NCP4589

300 mA, Tri-Mode, LDO Linear Voltage Regulator

The NCP4589 is a CMOS 300 mA LDO which switches to a low power mode under light current loads. The device automatically switches back to a fast response mode as the output load increases above 3 mA (typ.). The device can be placed in permanent fast mode through a mode select pin. The family is available in a variety of packages: SC−70, SOT23 and a small, ultra thin 1.2 x 1.2 x 0.4 mm XDFN.

Features

- Operating Input Voltage Range: 1.4 V to 5.25 V
- Output Voltage Range: 0.8 to 4.0 V (available in 0.1 V steps)
- Supply Current: Low Power Mode – 1.0 μA at V_{OUT} < 1.85 V
  Fast Mode – 55 μA
  Standby Mode – 0.1 μA
- Dropout Voltage: 230 mV Typ. at I_{OUT} = 300 mA, V_{OUT} = 2.8 V
- ±1% Output Voltage Accuracy (V_{OUT} > 2 V, T_J = 25 °C)
- High PSRR: 70 dB at 1 kHz (Fast response mode)
- Line Regulation 0.02%/V Typ.
- Current Fold Back Protection
- Stable with Ceramic Capacitors
- Available in 1.2x1.2 XDFN, SC−70 and SOT23 Package
- These are Pb−free Devices

Typical Applications

- Battery Powered Equipments
- Portable Communication Equipments
- Cameras, Image Sensors and Camcorders

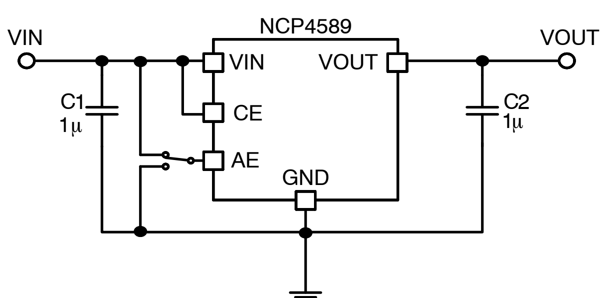
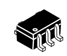


Figure 1. Typical Application Schematic

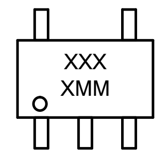
ON Semiconductor™

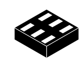
http://onsemi.com

MARKING DIAGRAMS

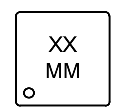


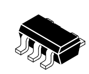
SC−70
CASE 419A



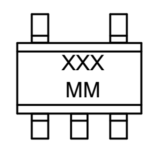


XDFN6
CASE 711AA





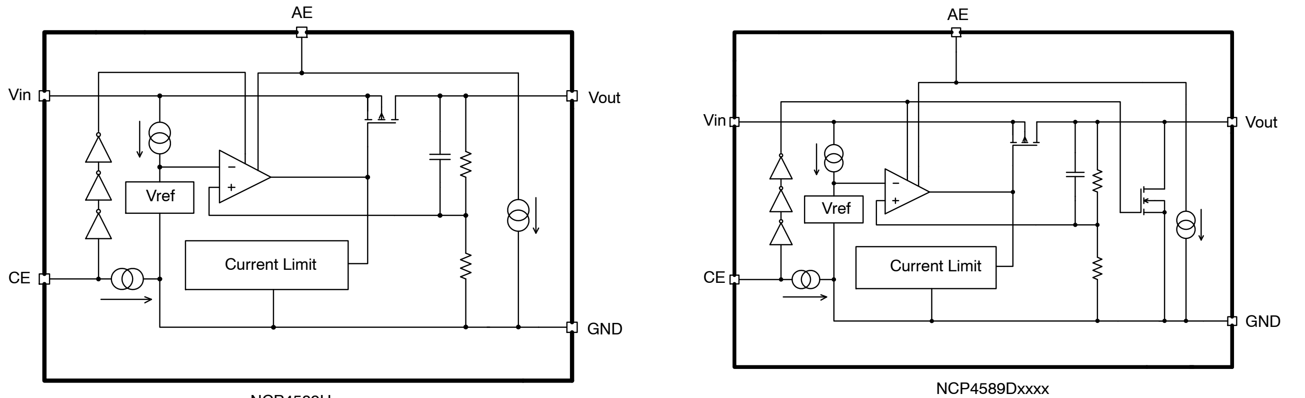
SOT−23−5
CASE 1212



XXXX = Specific Device Code
MM = Date Code

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 27 of this data sheet.



NCP4589Hxxxx

NCP4589Dxxxx

Figure 2. Simplified Schematic Block Diagram

PIN FUNCTION DESCRIPTION

Pin No. XDFN	Pin No. SC−70	Pin No. SOT23	Pin Name	Description
4	4	1	VIN	Input pin
2	2	2	GND	Ground
3	5	3	CE	Chip enable pin
6	3	5	VOUT	Output pin
1	1	4	AE	Auto Eco Pin
5	–	–	NC	No connection

ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Input Voltage (Note 1)	V_{IN}	6.0	V
Output Voltage	V_{OUT}	−0.3 to V_{IN} + 0.3	V
Chip Enable Input	V_{CE}	−0.3 to 6.0	V
Auto Eco Input	V_{AE}	−0.3 to 6.0	V
Output Current	I_{OUT}	400	mA
Power Dissipation XDFN	P_D	400	mW
Power Dissipation SC70		380	
Power Dissipation SOT23		420	
Junction Temperature	T_J	−40 to 150	°C
Storage Temperature	T_{STG}	−55 to 125	°C
Operation Temperature	T_A	−40 to 85	°C
ESD Capability, Human Body Model (Note 2)	ESD_{HBM}	2000	V
ESD Capability, Machine Model (Note 2)	ESD_{MM}	200	V

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Refer to ELECTRICAL CHARACTERISTIS and APPLICATION INFORMATION for Safe Operating Area.
2. This device series incorporates ESD protection and is tested by the following methods:
   ESD Human Body Model tested per AEC−Q100−002 (EIA/JESD22−A114)
   ESD Machine Model tested per AEC−Q100−003 (EIA/JESD22−A115)
   Latchup Current Maximum Rating tested per JEDEC standard: JESD78.

THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal Characteristics, XDFN Thermal Resistance, Junction−to−Air	$R_{\theta JA}$	250	°C/W
Thermal Characteristics, SOT23 Thermal Resistance, Junction−to−Air	$R_{\theta JA}$	238	°C/W
Thermal Characteristics, SC−70 Thermal Resistance, Junction−to−Air	$R_{\theta JA}$	263	°C/W

ELECTRICAL CHARACTERISTICS

−40°C ≤ T_A ≤ 85°C; $V_{IN} = V_{OUT(NOM)} + 1$ V; I_{OUT} = 1 mA; $C_{IN} = C_{OUT}$ = 1 μF; unless otherwise noted. Typical values are at T_A = +25°C.

Parameter	Test Conditions		Symbol	Min	Typ	Max	Unit
Operating Input Voltage	(Note NO TAG)		V_{IN}	1.4		5.25	V
Output Voltage (Fast Mode)	T_A = +25°C, I_{OUT} = 5 mA	V_{OUT} > 2 V	V_{OUT}	x0.99		x1.01	V
		V_{OUT} ≤ 2 V		−20		20	mV
	−40°C ≤ T_A ≤ 85°C, I_{OUT} = 5 mA	V_{OUT} > 2 V		x0.975		x1.015	V
		V_{OUT} ≤ 2 V		−50		30	mV
Output Voltage Temp. Coefficient	T_A = −40 to 85°C				±50		ppm/°C
Line Regulation	$V_{IN} = V_{OUT}$ + 0.5 V to 5 V V_{IN} ≥ 1.4 V	I_{OUT} = 1 mA, (Low Power Mode)	$Line_{Reg}$			0.50	%/V
		I_{OUT} = 10 mA, (Fast Mode)			0.02	0.20	
Load Regulation	I_{OUT} = 1 mA to 10 mA	V_{OUT} > 2.0 V	$Line_{Reg}$	−1.0		1.0	%
		V_{OUT} ≤ 2.0 V		−20		20	mV
	I_{OUT} = 10 mA to 300 mA				35	80	mV
Dropout Voltage	I_{OUT} = 300 mA	0.8 V ≤ V_{OUT} < 0.9 V	V_{DO}		0.62	0.85	V
		0.9 V ≤ V_{OUT} < 1.0 V			0.55	0.78	
		1.0 V ≤ V_{OUT} < 1.5 V			0.48	0.70	
		1.5 V ≤ V_{OUT} < 2.6 V			0.34	0.50	
		2.6 V ≤ V_{OUT} < 4.0 V			0.23	0.35	
Output Current			I_{OUT}	300			mA
Short Current Limit	V_{OUT} = 0 V		I_{SC}		50		mA
Quiescent Current	I_{OUT} = 0 mA, Low Power Mode (Note 3)	V_{OUT} ≤ 1.85 V	I_Q		1.0	4.0	μA
		V_{OUT} > 1.85 V			1.5	4.0	
Supply Current	I_{OUT} = 10 mA, Fast Mode		I_{GND}		55		μA
Standby Current	V_{CE} = 0 V, T_A = 25°C		I_{STB}		0.1	1	μA
Fast Mode Switch−Over Current	I_{OUT} = light to heavy load		I_{OUTH}			8.0	mA
Low Power Switch−Over Current	I_{OUT} = heavy to light load		I_{OUTL}	1.0	2.0		mA
CE Pin Threshold Voltage	CE Input Voltage “H”		V_{CEH}	1.0			V
	CE Input Voltage “L”		V_{CEL}			0.4	
CE Pull Down Current			I_{CEPD}		0.1		μA
AE Pin Threshold Voltage	AE Input Voltage “H”		V_{AEH}	1.0			V
	AE Input Voltage “L”		V_{AEL}			0.4	

3. The value of supply current is excluding the Pull−down constant current of CE and AE Pin

ELECTRICAL CHARACTERISTICS

$-40°C \le T_A \le 85°C$; $V_{IN} = V_{OUT(NOM)} + 1$ V; $I_{OUT} = 1$ mA; $C_{IN} = C_{OUT} = 1$ µF; unless otherwise noted. Typical values are at $T_A = +25°C$.

Parameter	Test Conditions	Symbol	Min	Typ	Max	Unit
AE Pull Down Current		I_{AEPD}		0.1		µA
Power Supply Rejection Ratio	$V_{IN} = V_{OUT} + 1$ V or 2.2 V whichever is higher, $\Delta V_{IN} = 0.2\ V_{pk-pk}$, $I_{OUT} = 30$ mA, f = 1 kHz, Fast Mode	PSRR		70		dB
Output Noise Voltage	$V_{OUT} = 1.0$ V, $I_{OUT} = 30$ mA, f = 10 Hz to 100 kHz	V_N		90		μV_{rms}
Low Output N−channel Tr. On Resistance	$V_{IN} = 4$ V, $V_{CE} = 0$ V	R_{LOW}		50		Ω

3. The value of supply current is excluding the Pull−down constant current of CE and AE Pin

TYPICAL CHARACTERISTICS

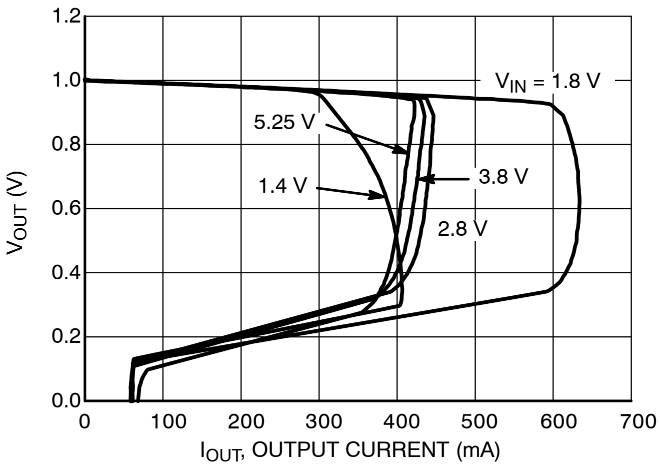


Figure 3. Output Voltage vs. Output Current 1.0 V Version (T_J = 25°C)

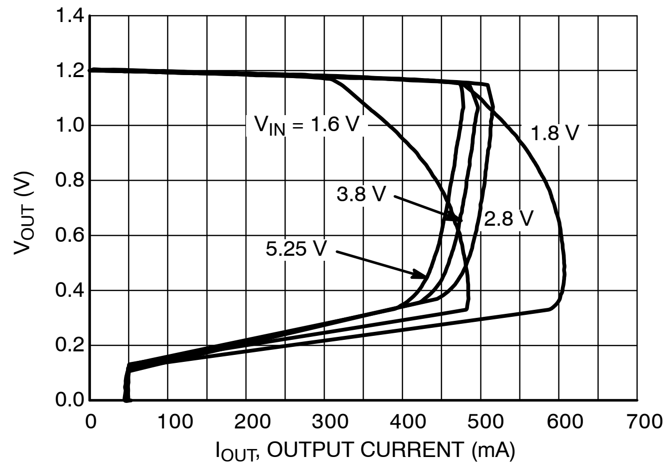


Figure 4. Output Voltage vs. Output Current 1.2 V Version (T_J = 25°C)

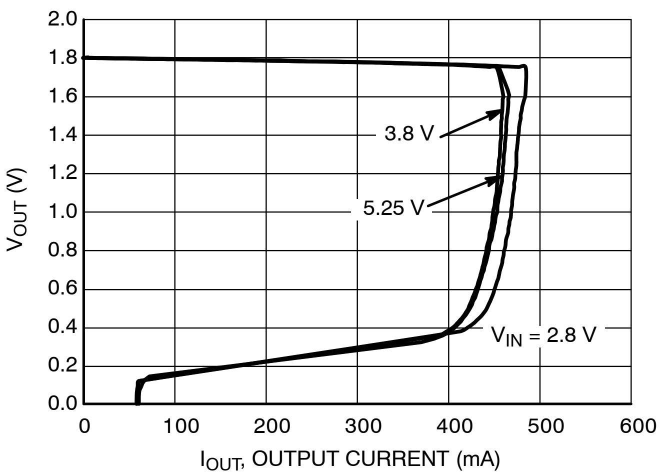


Figure 5. Output Voltage vs. Output Current 1.8 V Version (T_J = 25°C)

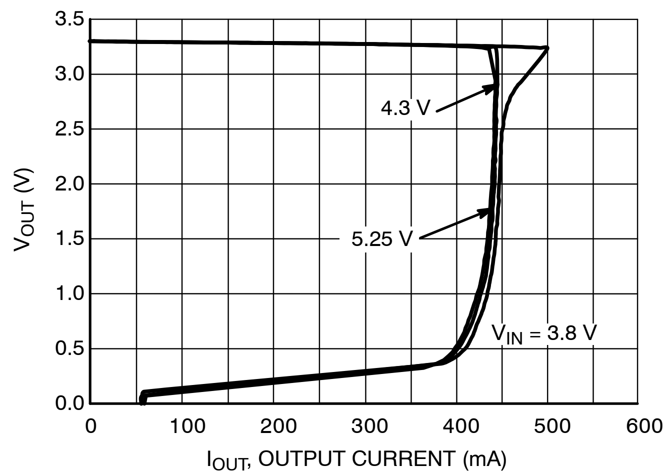


Figure 6. Output Voltage vs. Output Current 3.3 V Version (T_J = 25°C)

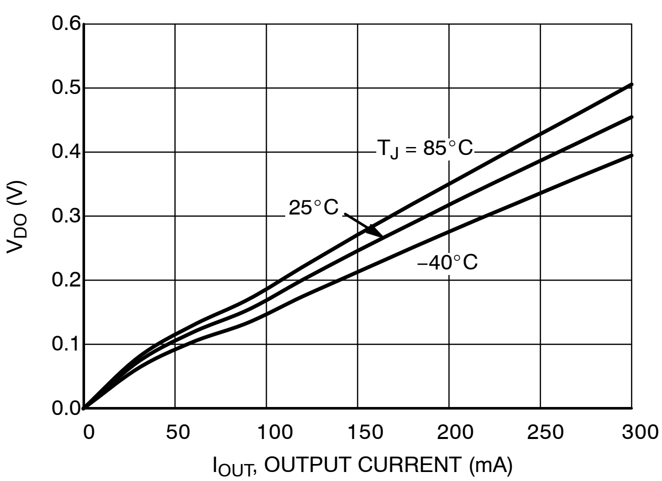


Figure 7. Dropout Voltage vs. Output Current 1.0 V Version

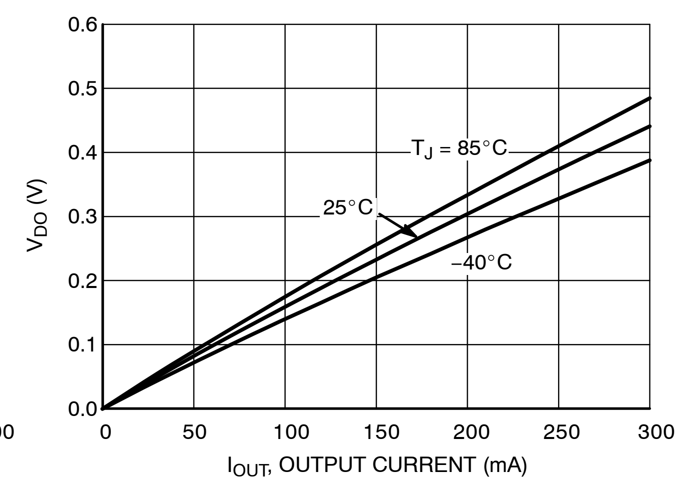


Figure 8. Dropout Voltage vs. Output Current 1.2 V Version

TYPICAL CHARACTERISTICS

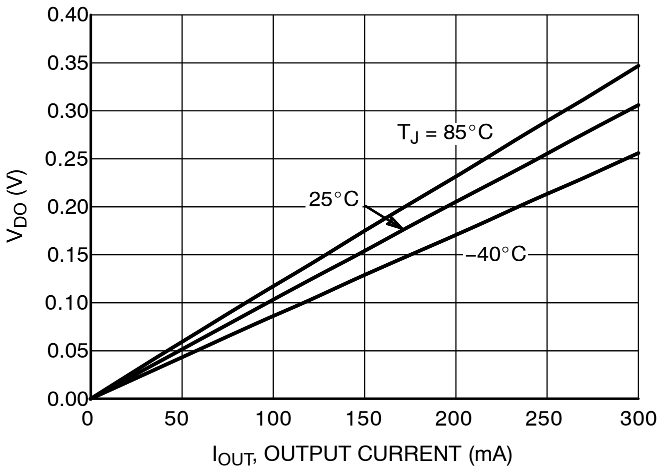


Figure 9. Dropout Voltage vs. Output Current 1.8 V Version

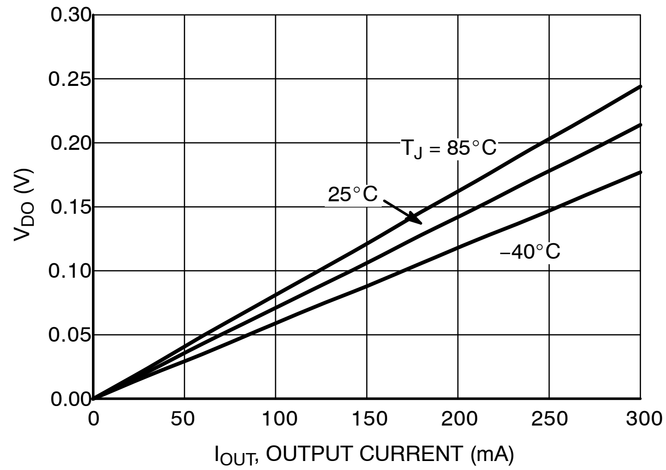


Figure 10. Dropout Voltage vs. Output Current 3.3 V Version

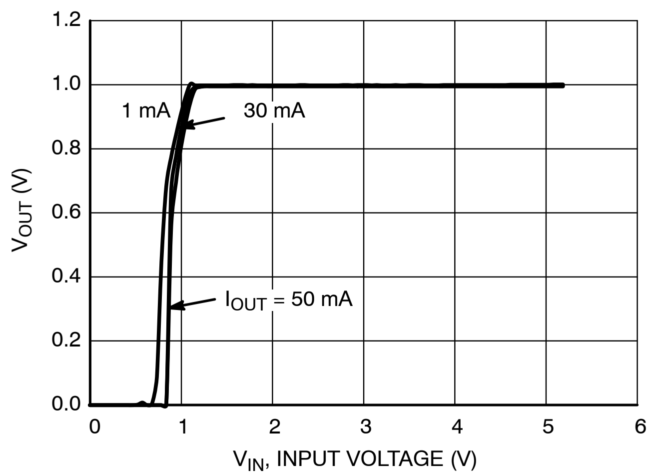


Figure 11. Output Voltage vs. Input Voltage, 1.0 V Version

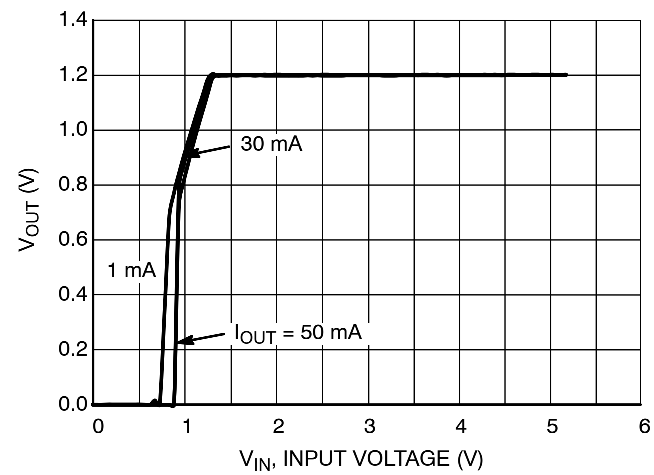


Figure 12. Output Voltage vs. Input Voltage, 1.2 V Version

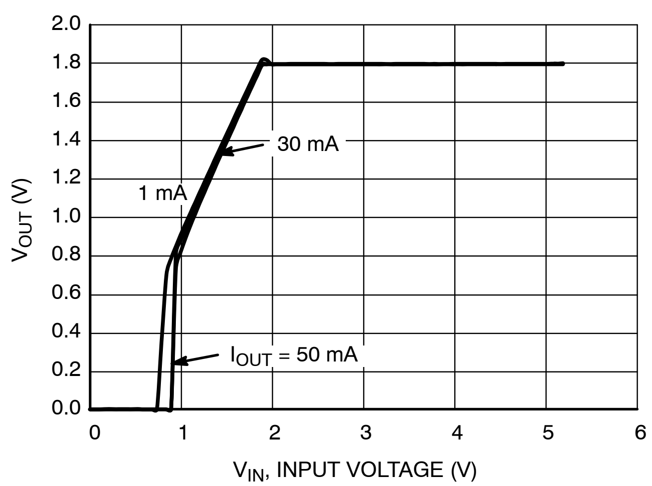


Figure 13. Output Voltage vs. Input Voltage, 1.8 V Version

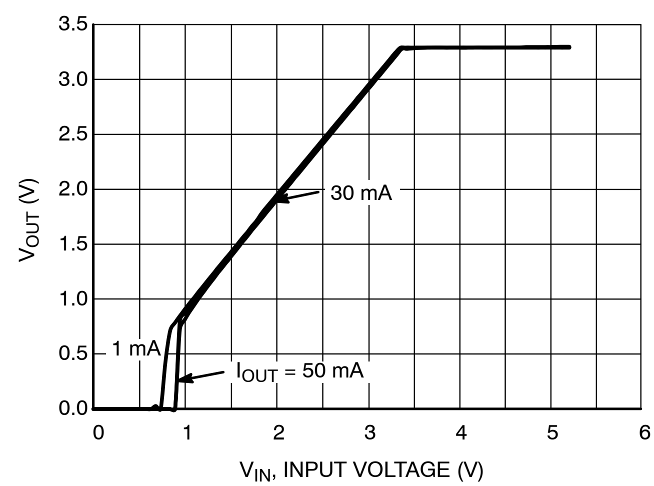


Figure 14. Output Voltage vs. Input Voltage, 3.3 V Version

TYPICAL CHARACTERISTICS

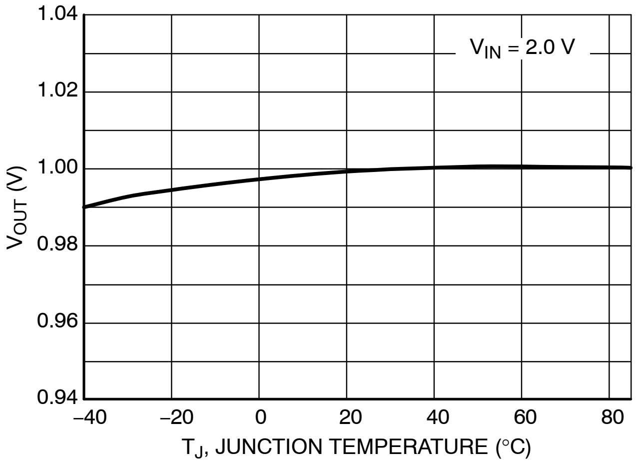


Figure 15. Output Voltage vs. Temperature, 1.0 V Version

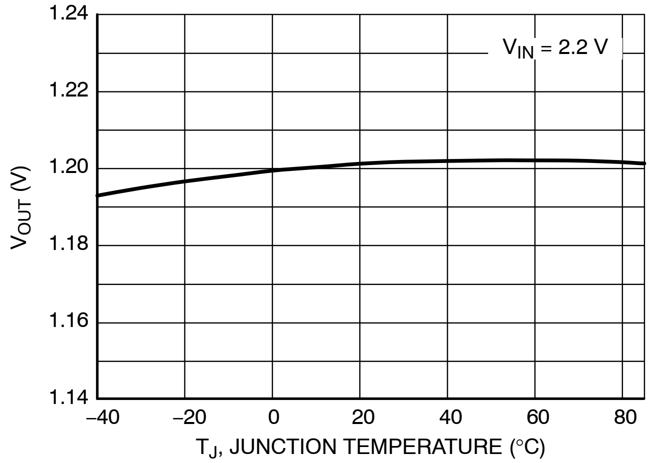


Figure 16. Output Voltage vs. Temperature, 1.2 V Version

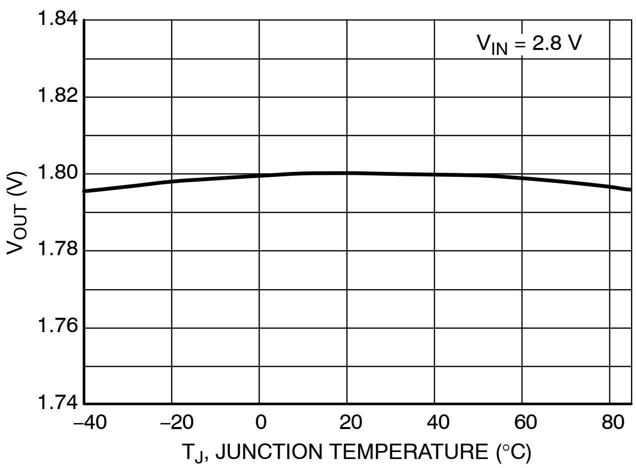


Figure 17. Output Voltage vs. Temperature, 1.8 V Version

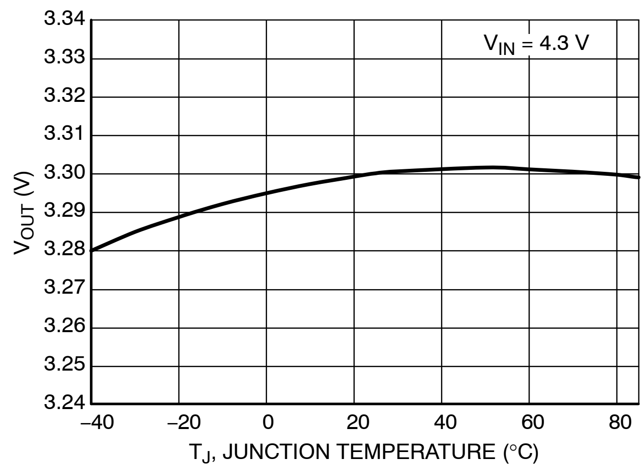


Figure 18. Supply Current vs. Input Voltage, 3.3 V Version

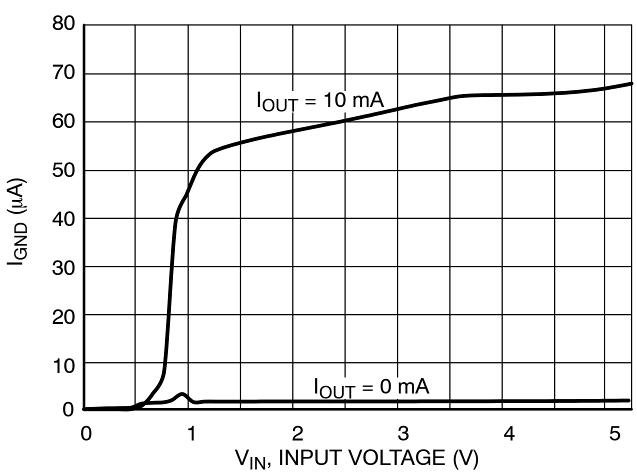


Figure 19. Supply Current vs. Input Voltage, 1.0 V Version

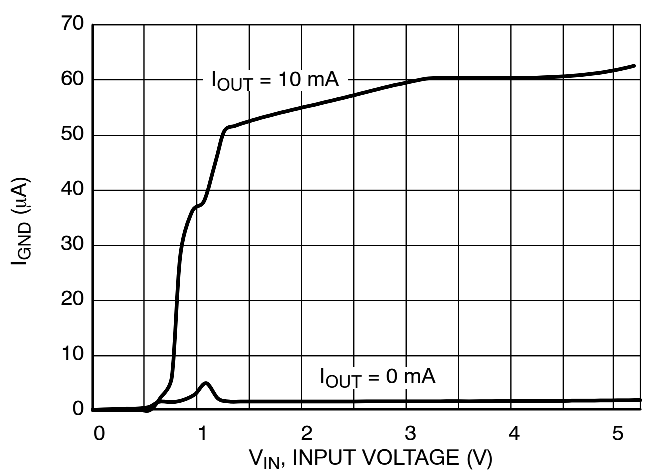


Figure 20. Supply Current vs. Input Voltage, 1.2 V Version

TYPICAL CHARACTERISTICS

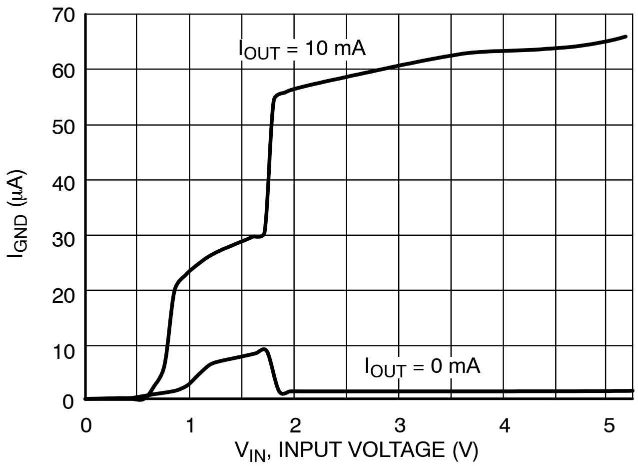


Figure 21. Supply Current vs. Input Voltage, 1.8 V Version

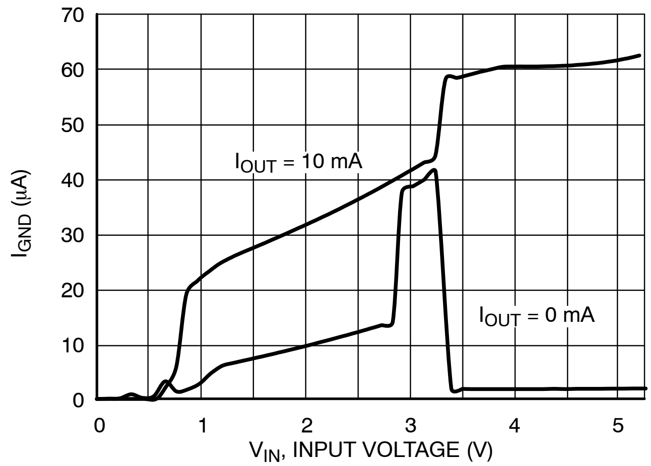


Figure 22. Supply Current vs. Input Voltage, 3.3 V Version

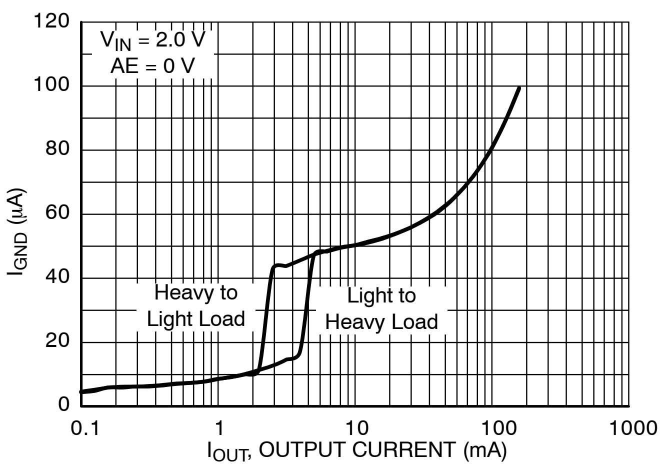


Figure 23. Supply Current vs. Output Current, 1.0 V Version

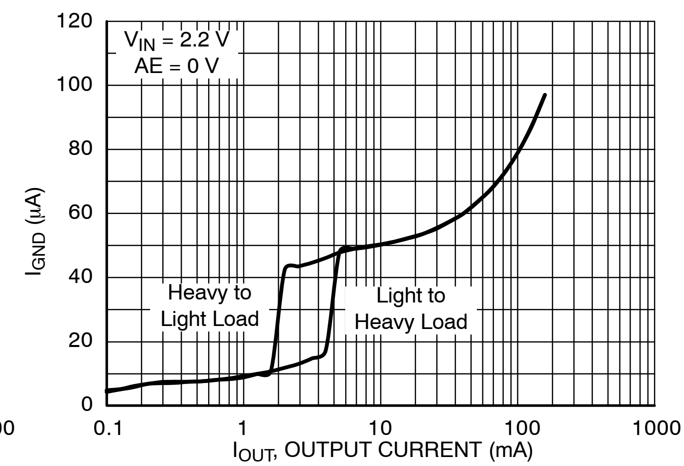


Figure 24. Supply Current vs. Output Current, 1.2 V Version

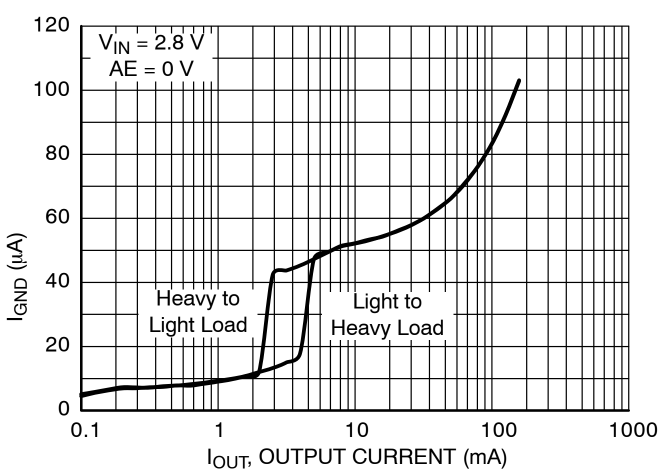


Figure 25. Supply Current vs. Output Current, 1.8 V Version

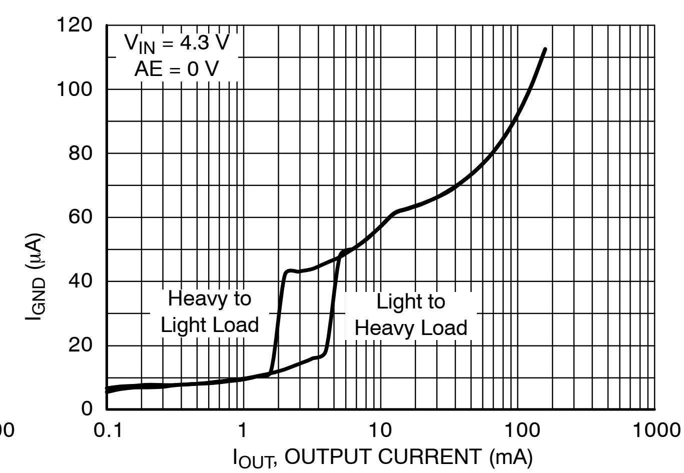


Figure 26. Supply Current vs. Output Current, 3.3 V Version

TYPICAL CHARACTERISTICS

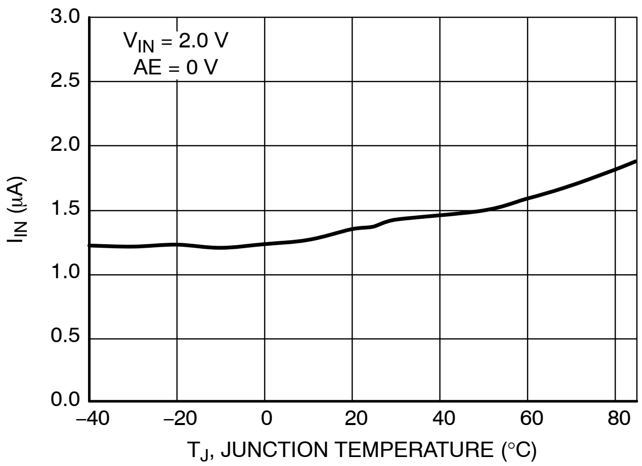


Figure 27. Supply Current vs. Temperature, 1.0 V Version

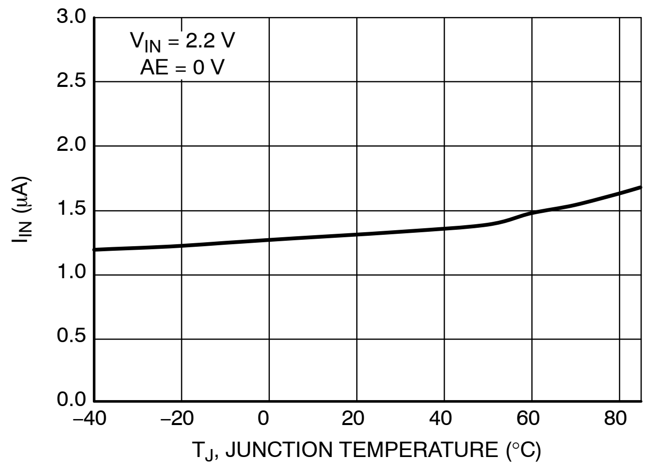


Figure 28. Supply Current vs. Temperature, 1.2 V Version

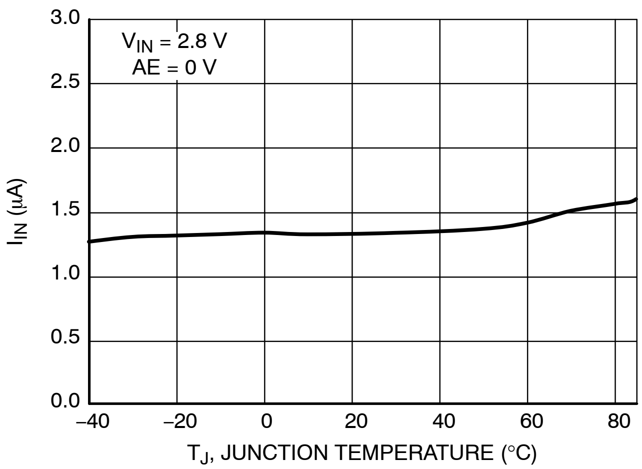


Figure 29. Supply Current vs. Temperature, 1.8 V Version

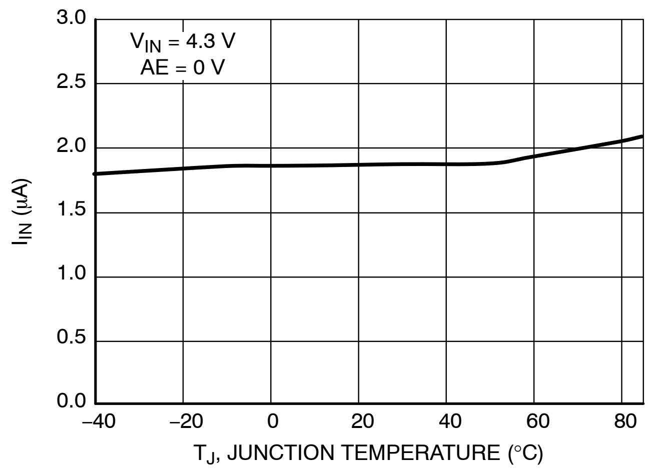


Figure 30. Supply Current vs. Temperature, 3.3 V Version

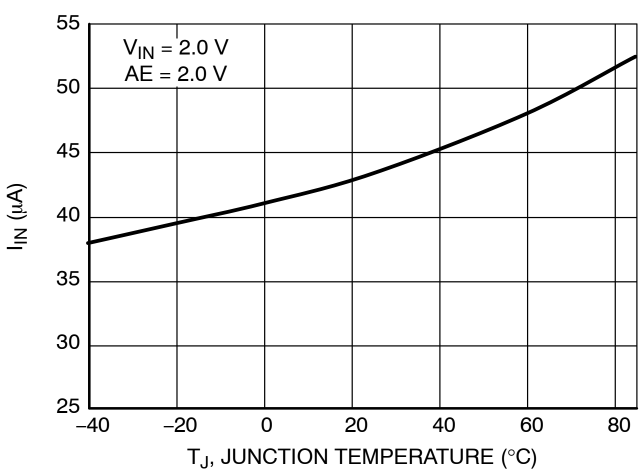


Figure 31. Supply Current vs. Temperature, 1.0 V Version

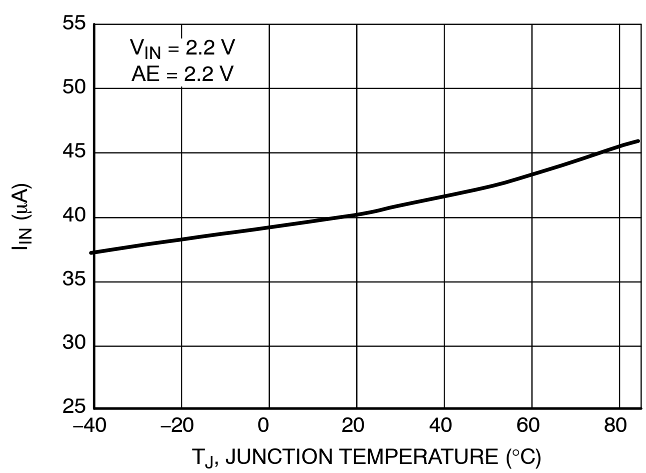


Figure 32. Supply Current vs. Temperature, 1.2 V Version

TYPICAL CHARACTERISTICS

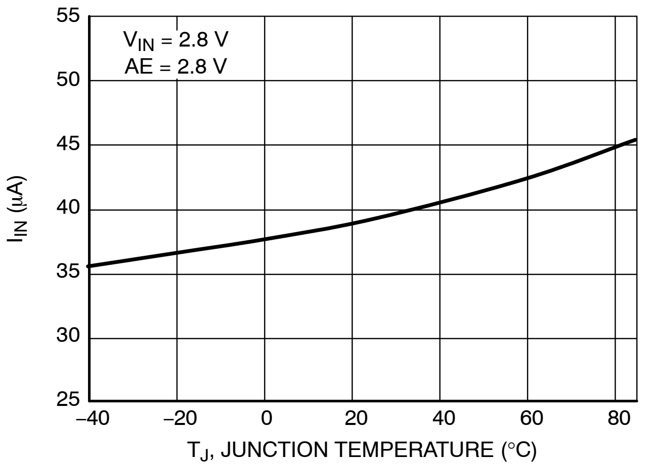


Figure 33. Supply Current vs. Temperature, 1.8 V Version

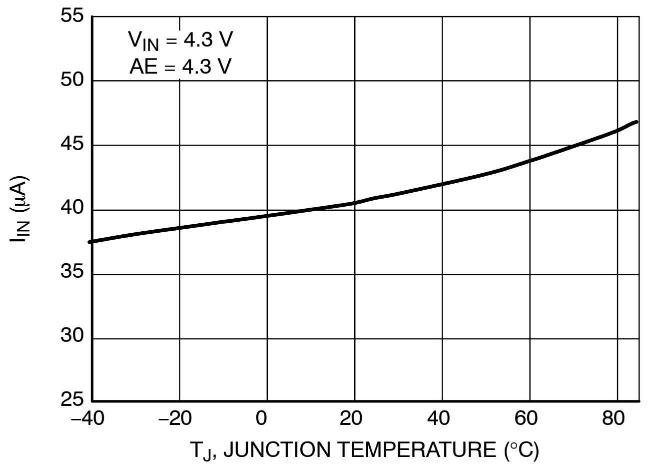


Figure 34. Supply Current vs. Temperature, 3.3 V Version

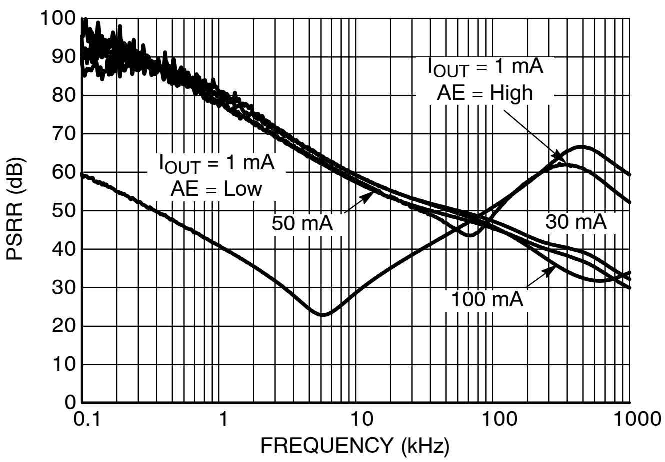


Figure 35. PSRR, 1.0 V Version, V_{IN} = 2.2 V

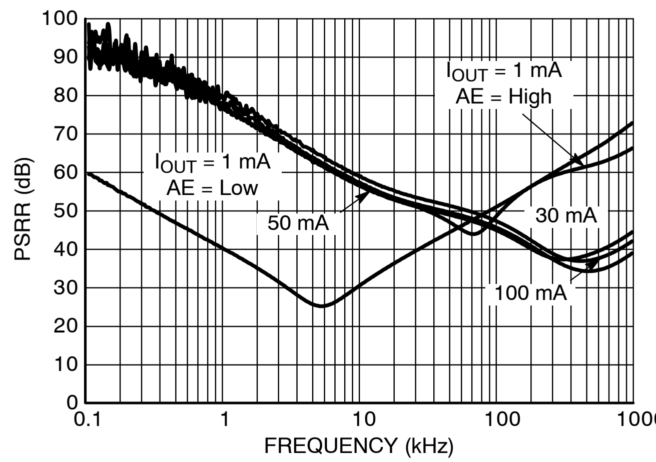


Figure 36. PSRR, 1.2 V Version, V_{IN} = 2.2 V

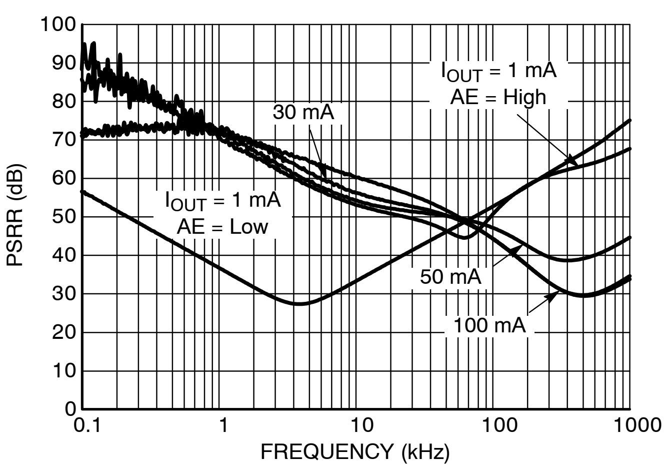


Figure 37. PSRR, 1.8 V Version, V_{IN} = 3.8 V

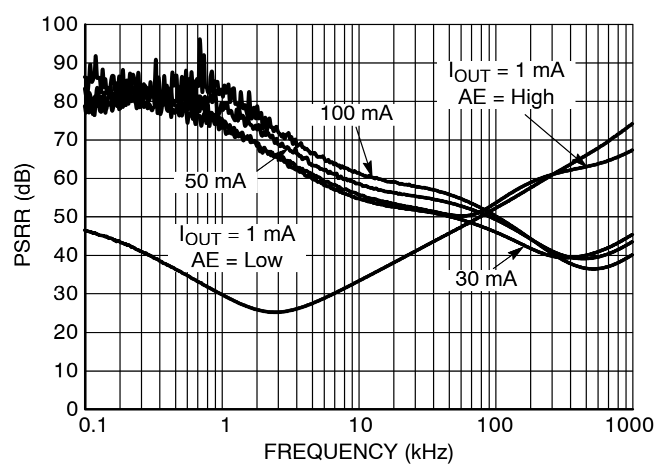


Figure 38. PSRR, 3.3 V Version, V_{IN} = 4.3 V

TYPICAL CHARACTERISTICS

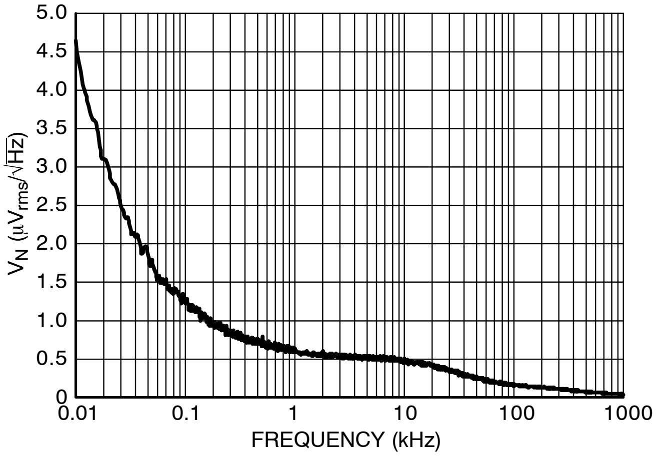


Figure 39. Output Voltage Noise, 1.0 V Version, V_{IN} = 2.0 V, I_{OUT} = 30 mA

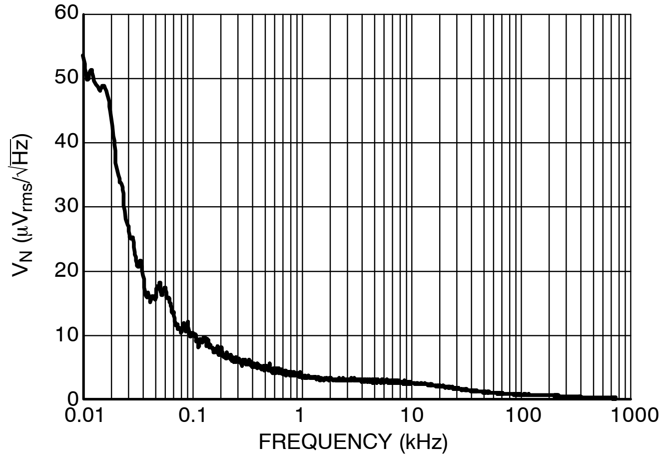


Figure 40. Output Voltage Noise, 1.2 V Version, V_{IN} = 2.2 V, I_{OUT} = 30 mA

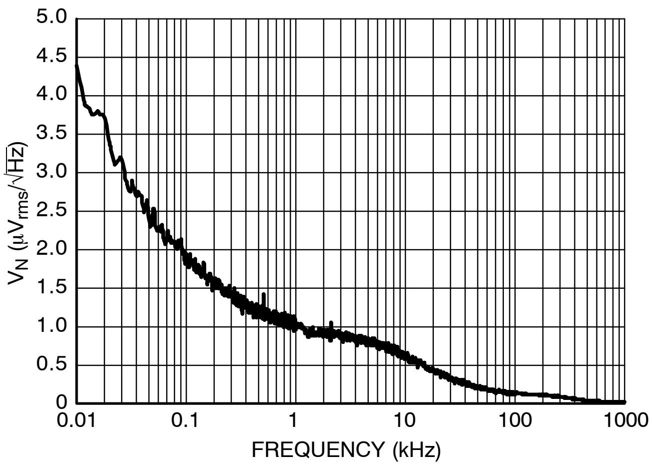


Figure 41. Output Voltage Noise, 1.8 V Version, V_{IN} = 2.8 V, I_{OUT} = 30 mA

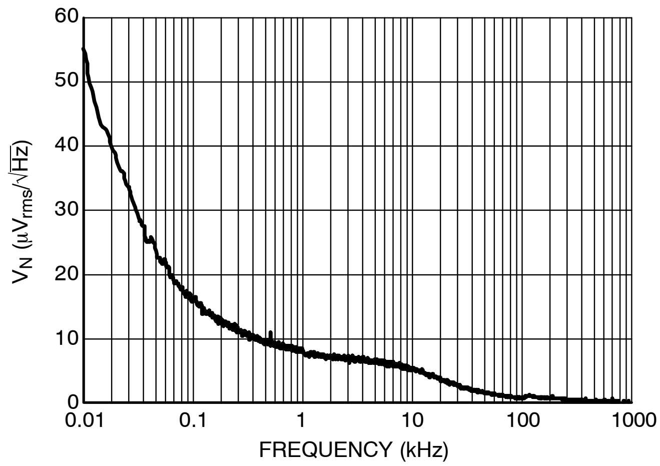


Figure 42. Output Voltage Noise, 3.3 V Version, V_{IN} = 4.3 V, I_{OUT} = 30 mA

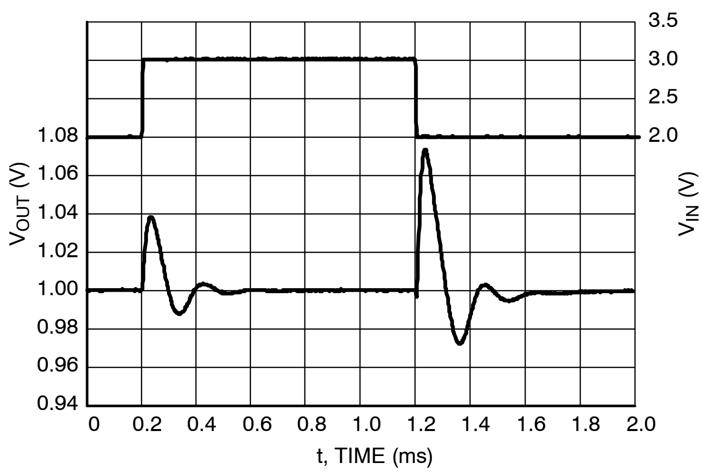


Figure 43. Line Transients, 1.0 V Version, t_R = t_F = 5 μs, I_{OUT} = 1 mA, AE = 0 V

TYPICAL CHARACTERISTICS

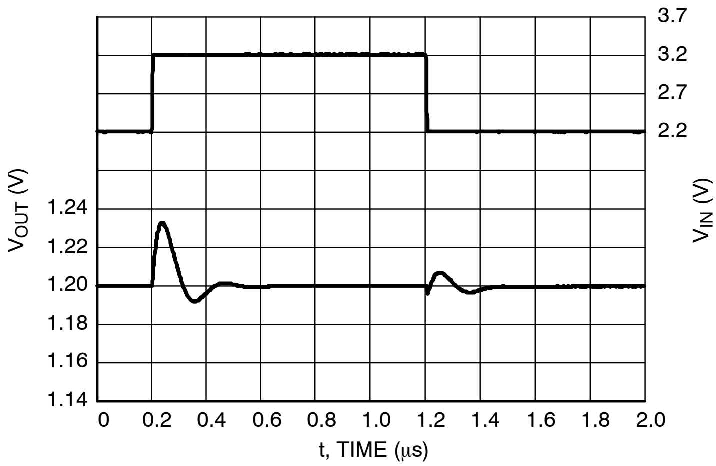


Figure 44. Line Transients, 1.2 V Version, t_R = t_F = 5 μs, I_{OUT} = 1 mA, AE = 0 V

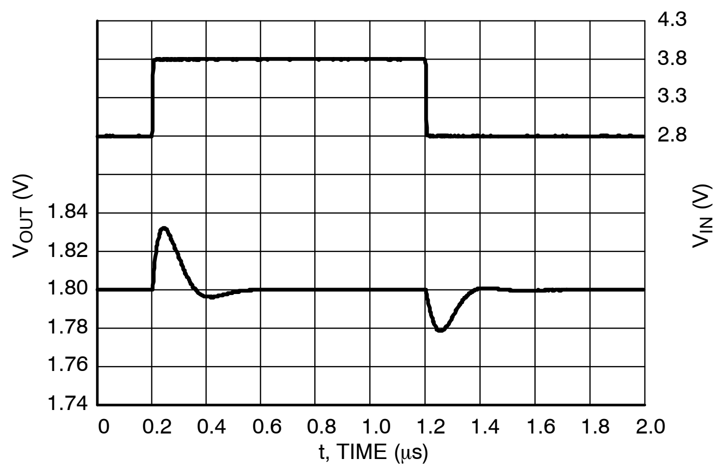


Figure 45. Line Transients, 1.8 V Version, t_R = t_F = 5 μs, I_{OUT} = 1 mA, AE = 0 V

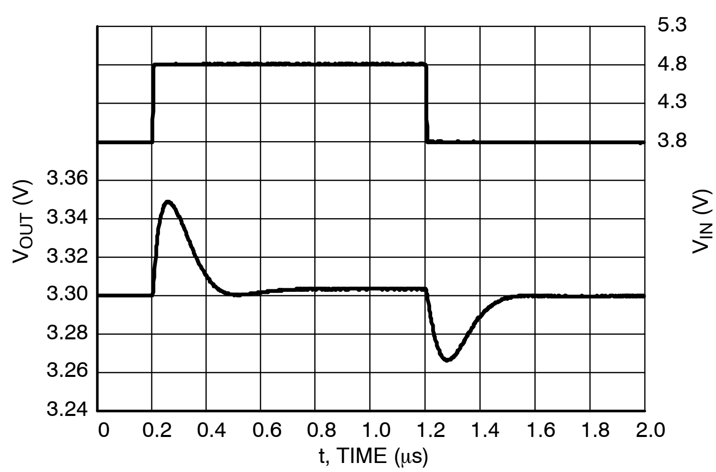


Figure 46. Line Transients, 3.3 V Version, t_R = t_F = 5 μs, I_{OUT} = 1 mA, AE = 0 V

TYPICAL CHARACTERISTICS

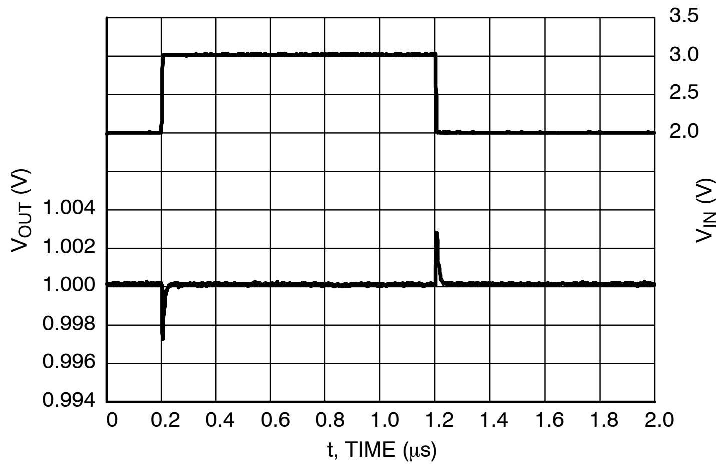


Figure 47. Line Transients, 1.0 V Version, t_R = t_F = 5 μs, I_{OUT} = 30 mA, AE = V_{IN} V

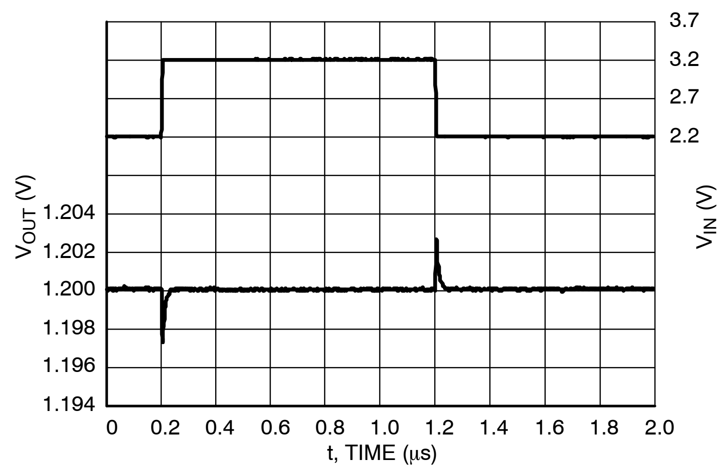


Figure 48. Line Transients, 1.2 V Version, t_R = t_F = 5 μs, I_{OUT} = 30 mA, AE = V_{IN} V

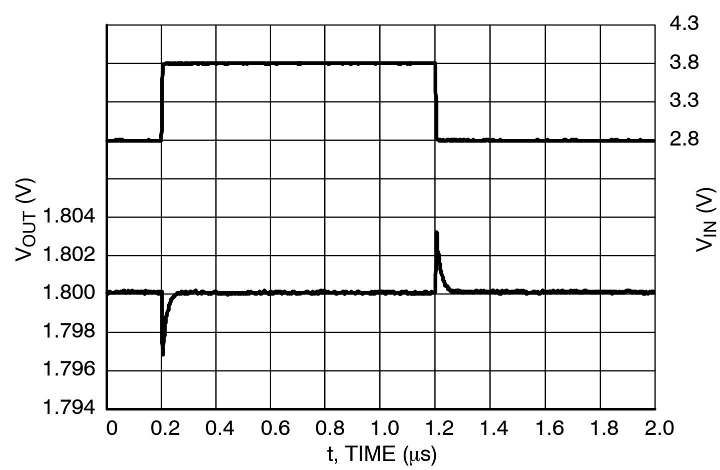


Figure 49. Line Transients, 1.8 V Version, t_R = t_F = 5 μs, I_{OUT} = 30 mA, AE = V_{IN} V

TYPICAL CHARACTERISTICS

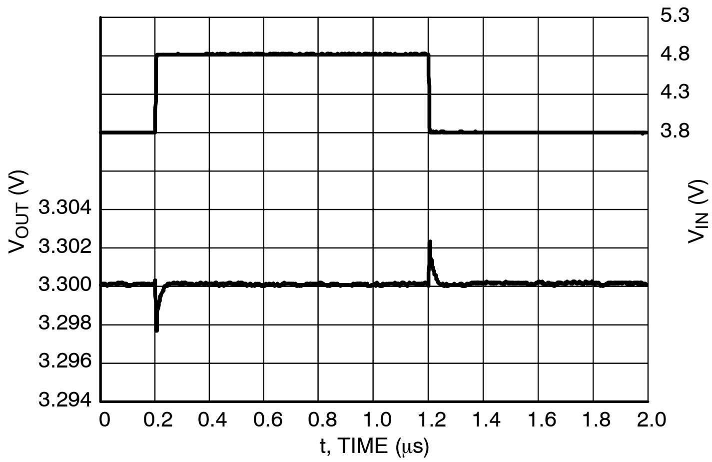


Figure 50. Line Transients, 3.3 V Version,
t_R = t_F = 5 μs, I_{OUT} = 30 mA, AE = V_{IN} V

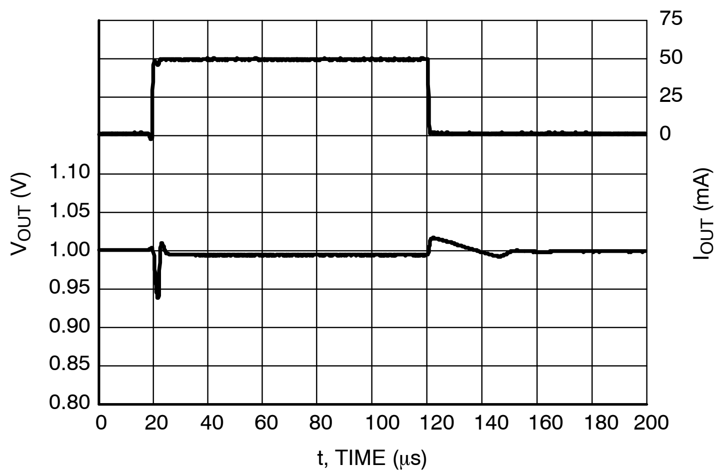


Figure 51. Load Transients, 1.0 V Version,
I_{OUT} = 1 − 50 mA, t_R = t_F = 0.5 μs, V_{IN} = 2.0 V,
AE = 0 V

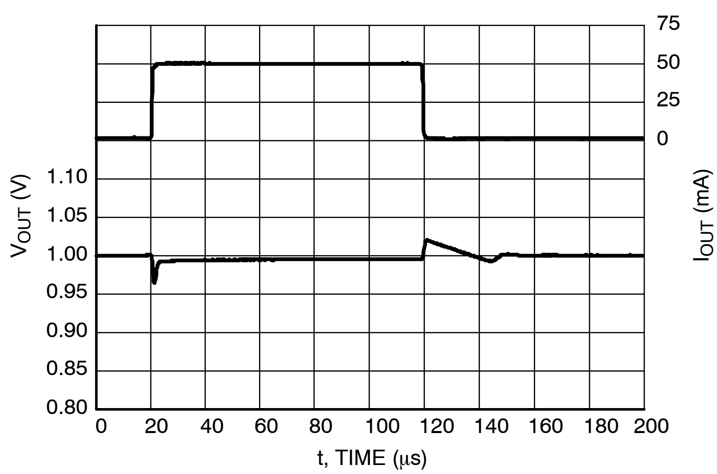


Figure 52. Load Transients, 1.0 V Version,
I_{OUT} = 1 − 50 mA, t_R = t_F = 0.5 μs, V_{IN} = 2.0 V,
AE = V_{IN} V

TYPICAL CHARACTERISTICS

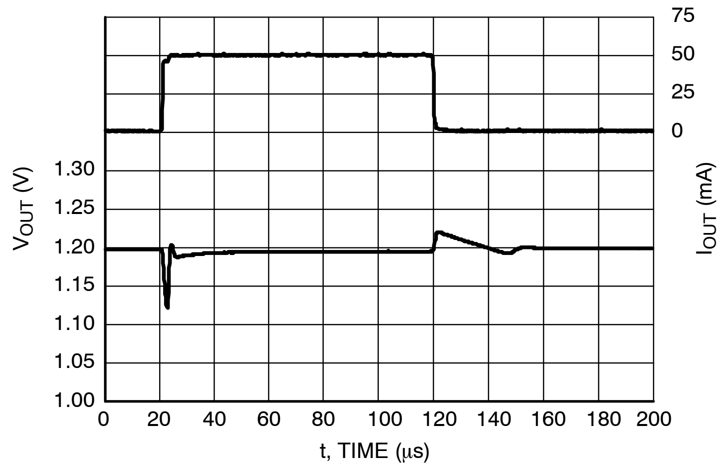


Figure 53. Load Transients, 1.2 V Version, I_{OUT} = 1 − 50 mA, t_R = t_F = 0.5 μs, V_{IN} = 2.2 V, AE = 0 V

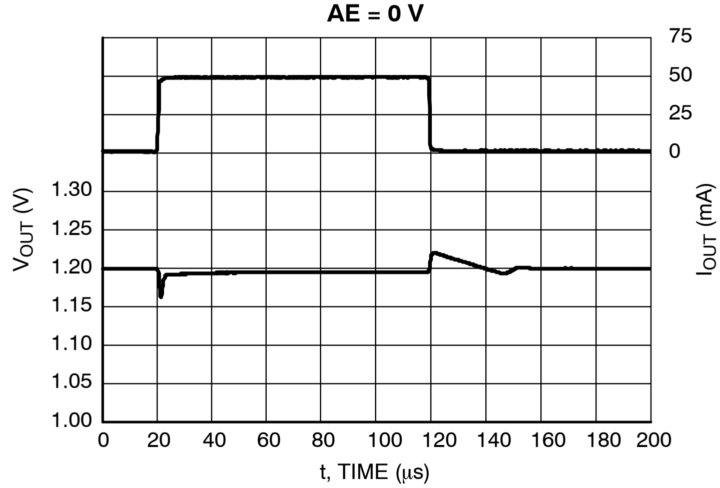


Figure 54. Load Transients, 1.2 V Version, I_{OUT} = 1 − 50 mA, t_R = t_F = 0.5 μs, V_{IN} = 2.2 V, AE = V_{IN} V

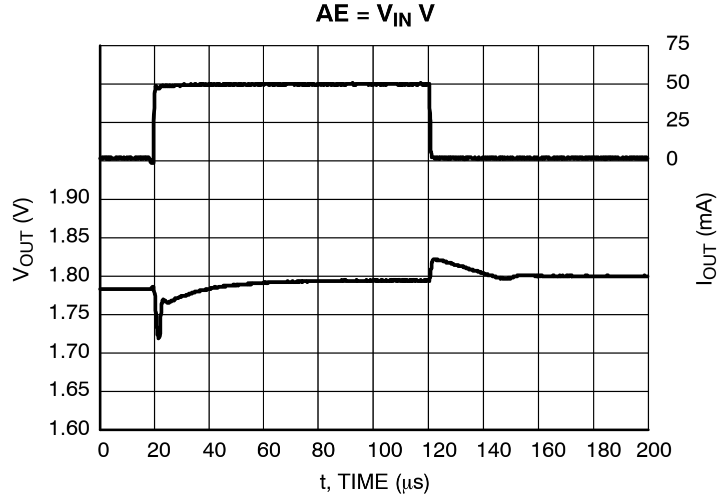


Figure 55. Load Transients, 1.8 V Version, I_{OUT} = 1 − 50 mA, t_R = t_F = 0.5 μs, V_{IN} = 2.8 V, AE = 0 V

TYPICAL CHARACTERISTICS

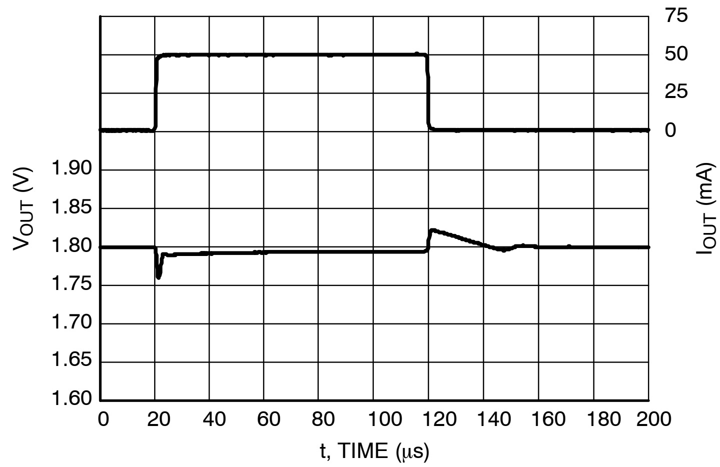


Figure 56. Load Transients, 1.8 V Version, I_{OUT} = 1 − 50 mA, $t_R = t_F$ = 0.5 μs, V_{IN} = 2.8 V, AE = V_{IN} V

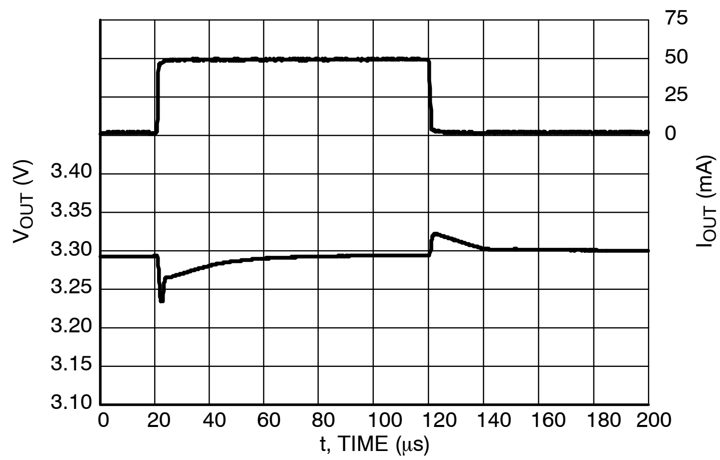


Figure 57. Load Transients, 3.3 V Version, I_{OUT} = 1 − 50 mA, $t_R = t_F$ = 0.5 μs, V_{IN} = 4.3 V, AE = 0 V

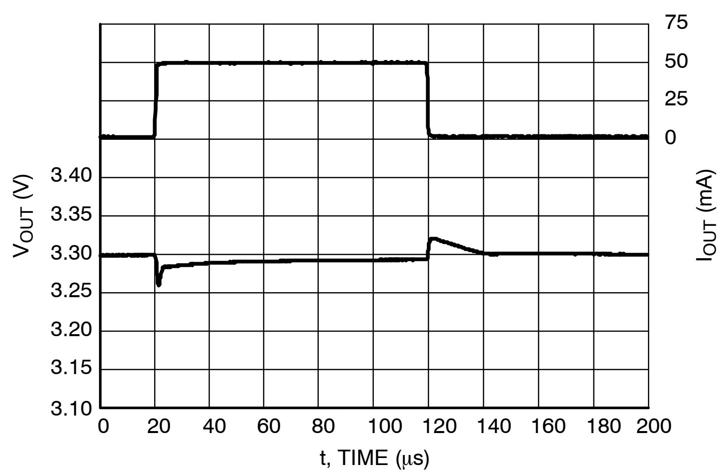


Figure 58. Load Transients, 3.3 V Version, I_{OUT} = 1 − 50 mA, $t_R = t_F$ = 0.5 μs, V_{IN} = 4.3 V, AE = V_{IN} V

TYPICAL CHARACTERISTICS

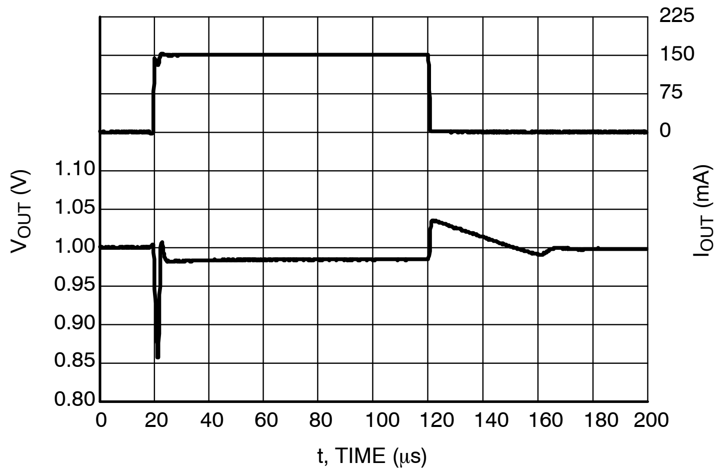


Figure 59. Load Transients, 1.0 V Version, I_{OUT} = 1 − 150 mA, t_R = t_F = 0.5 μs, V_{IN} = 2.0 V, AE = 0 V

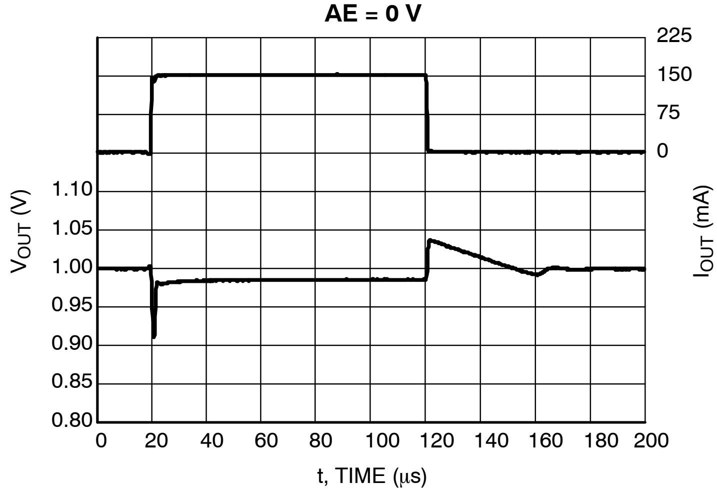


Figure 60. Load Transients, 1.0 V Version, I_{OUT} = 1 − 150 mA, t_R = t_F = 0.5 μs, V_{IN} = 2.0 V, AE = V_{IN} V

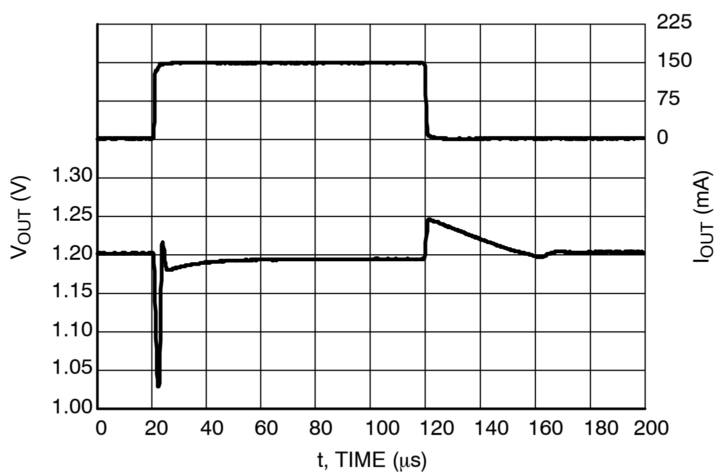


Figure 61. Load Transients, 1.2 V Version, I_{OUT} = 1 − 150 mA, t_R = t_F = 0.5 μs, V_{IN} = 2.2 V, AE = 0 V

TYPICAL CHARACTERISTICS

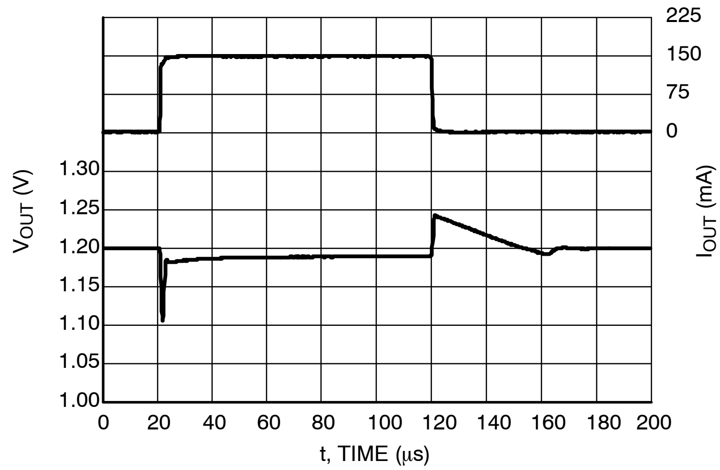


Figure 62. Load Transients, 1.2 V Version, I_{OUT} = 1 − 150 mA, $t_R = t_F$ = 0.5 μs, V_{IN} = 2.2 V, AE = V_{IN} V

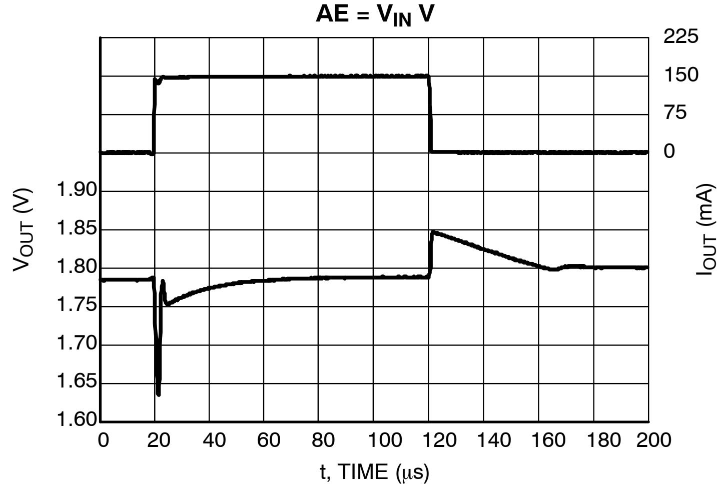


Figure 63. Load Transients, 1.8 V Version, I_{OUT} = 1 − 150 mA, $t_R = t_F$ = 0.5 μs, V_{IN} = 2.8 V, AE = 0 V

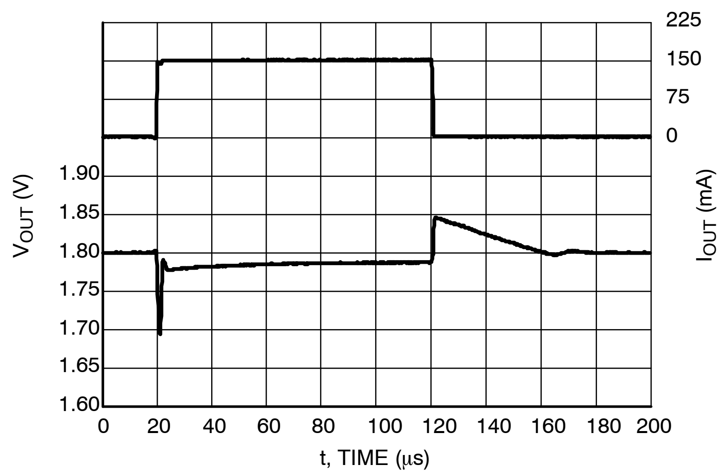


Figure 64. Load Transients, 1.8 V Version, I_{OUT} = 1 − 150 mA, $t_R = t_F$ = 0.5 μs, V_{IN} = 2.8 V, AE = V_{IN} V

TYPICAL CHARACTERISTICS

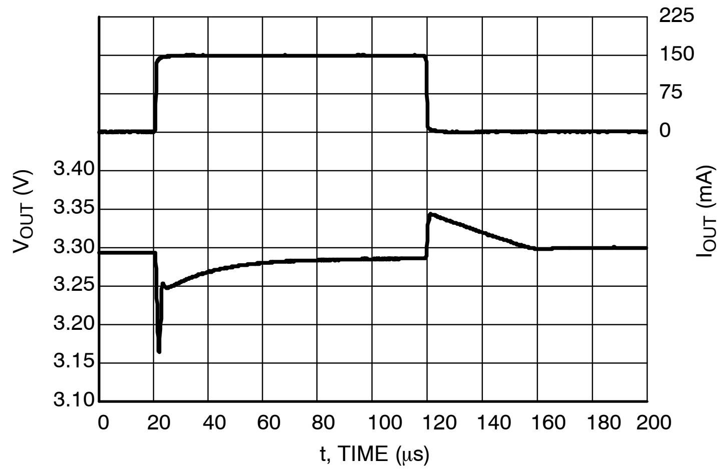


Figure 65. Load Transients, 3.3 V Version, I_{OUT} = 1 − 150 mA, $t_R = t_F$ = 0.5 μs, V_{IN} = 4.3 V, AE = 0 V

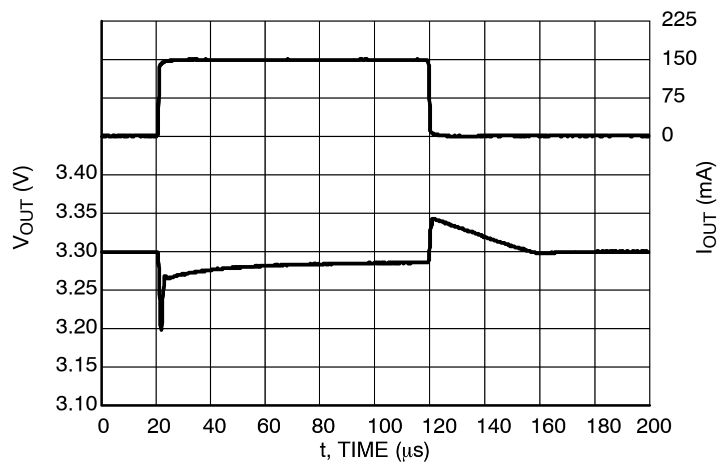


Figure 66. Load Transients, 3.3 V Version, I_{OUT} = 1 − 150 mA, $t_R = t_F$ = 0.5 μs, V_{IN} = 4.3 V, AE = V_{IN} V

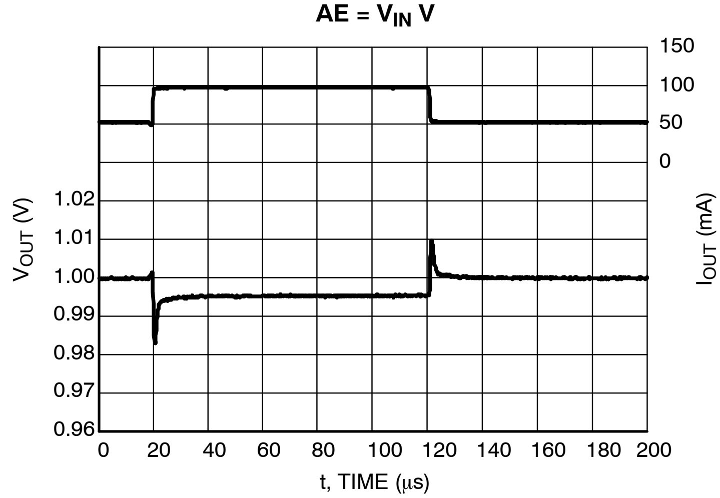


Figure 67. Load Transients, 1.0 V Version, I_{OUT} = 50 − 100 mA, $t_R = t_F$ = 0.5 μs, V_{IN} = 2.0 V, AE = 0 V

TYPICAL CHARACTERISTICS

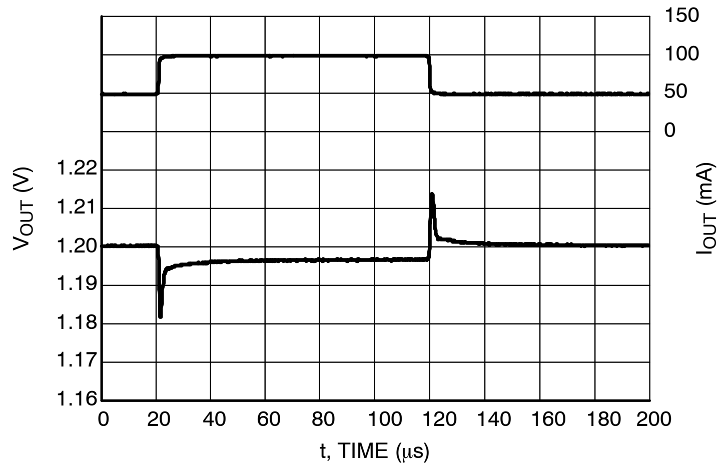


Figure 68. Load Transients, 1.2 V Version, I_{OUT} = 50 − 100 mA, $t_R = t_F$ = 0.5 μs, V_{IN} = 2.2 V, AE = V_{IN} V

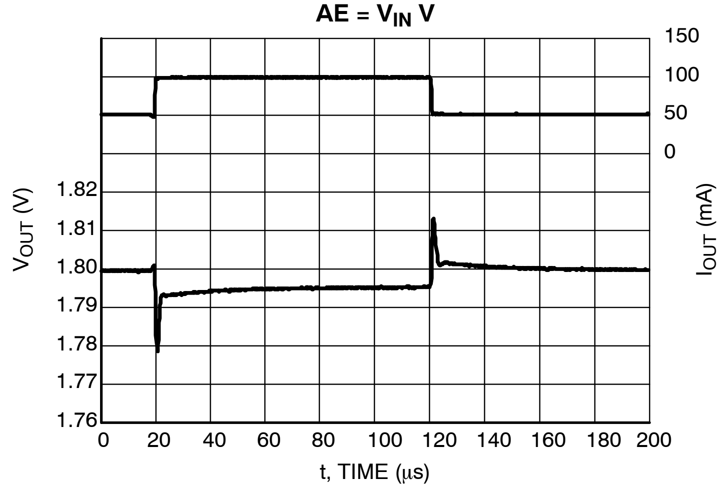


Figure 69. Load Transients, 1.8 V Version, I_{OUT} = 50 − 100 mA, $t_R = t_F$ = 0.5 μs, V_{IN} = 2.8 V, AE = V_{IN} V

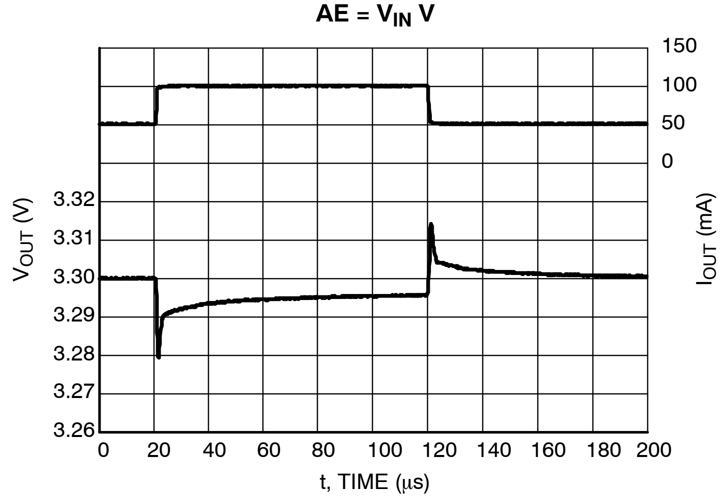


Figure 70. Load Transients, 3.3 V Version, I_{OUT} = 50 − 100 mA, $t_R = t_F$ = 0.5 μs, V_{IN} = 4.3 V, AE = V_{IN} V

TYPICAL CHARACTERISTICS

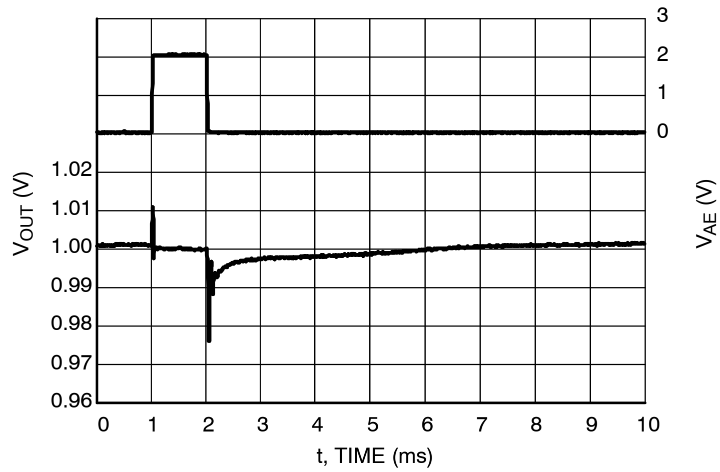


Figure 71. AE Switch Transients, 1.0 V Version, V_{IN} = 2.0 V, I_{OUT} = 1 mA

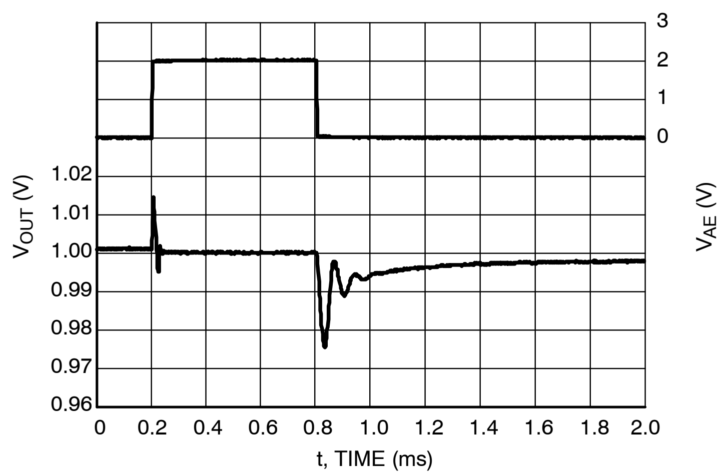


Figure 72. AE Switch Transients, 1.0 V Version, V_{IN} = 2.0 V, I_{OUT} = 1 mA

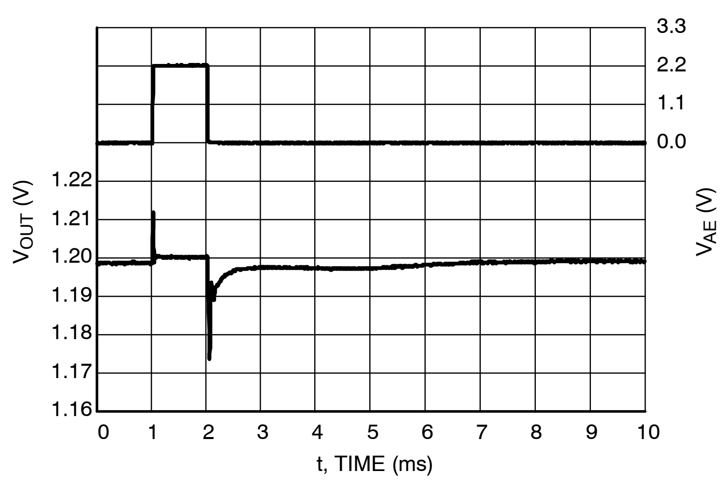


Figure 73. AE Switch Transients, 1.2 V Version, V_{IN} = 2.2 V, I_{OUT} = 1 mA

TYPICAL CHARACTERISTICS

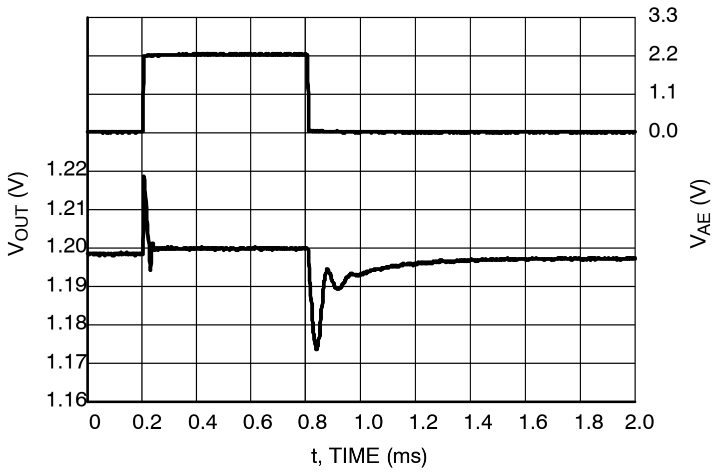


Figure 74. AE Switch Transients, 1.2 V Version, V_{IN} = 2.2 V, I_{OUT} = 1 mA

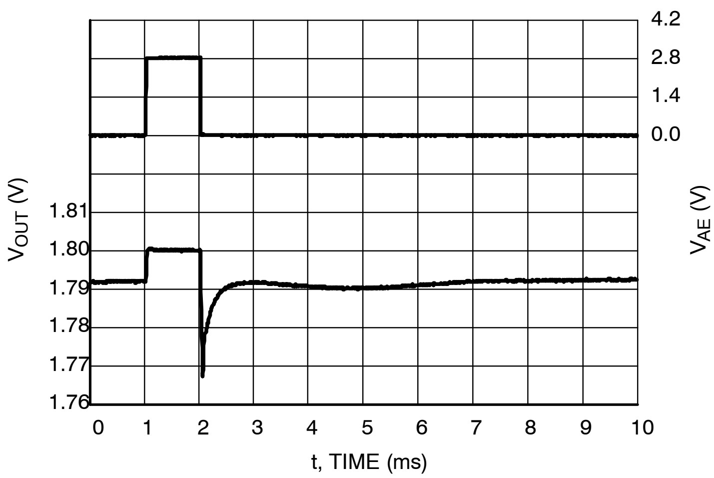


Figure 75. AE Switch Transients, 1.8 V Version, V_{IN} = 2.8 V, I_{OUT} = 1 mA

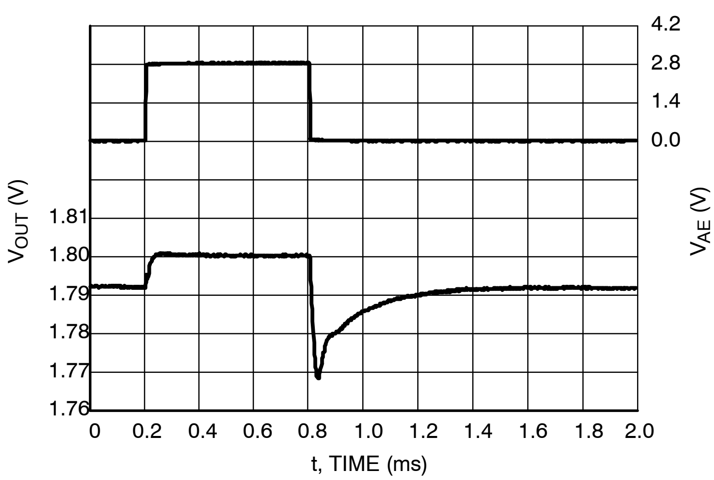


Figure 76. AE Switch Transients, 1.8 V Version, V_{IN} = 2.8 V, I_{OUT} = 1 mA

TYPICAL CHARACTERISTICS

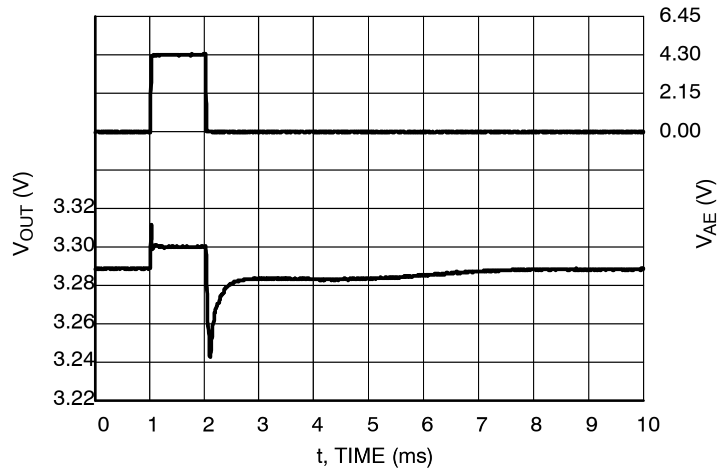


Figure 77. AE Switch Transients, 3.3 V Version, V_{IN} = 4.3 V, I_{OUT} = 1 mA

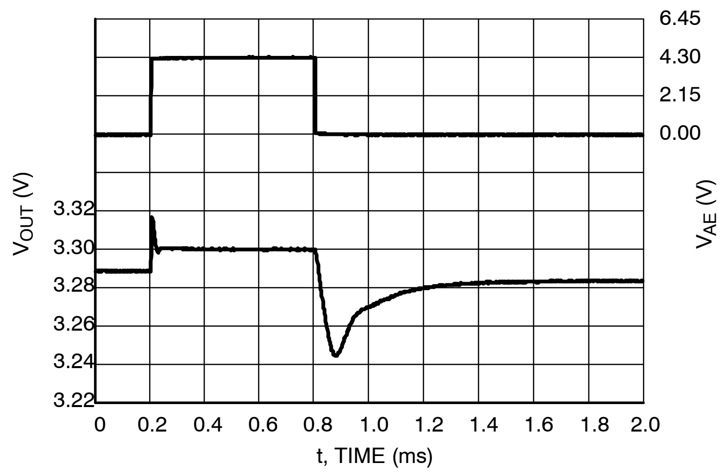


Figure 78. AE Switch Transients, 3.3 V Version, V_{IN} = 4.3 V, I_{OUT} = 1 mA

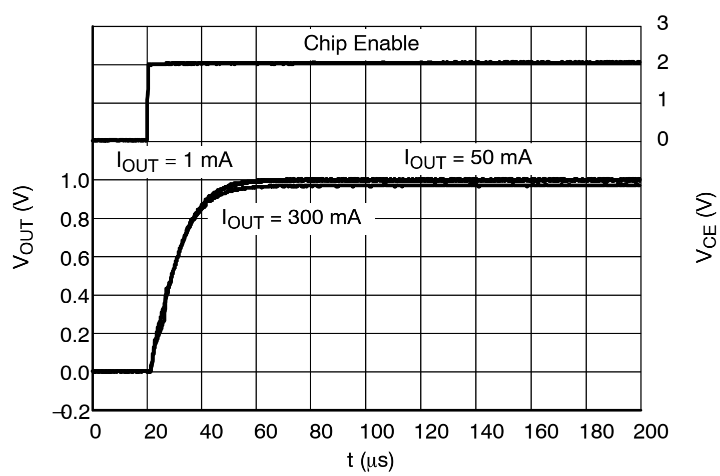


Figure 79. Start−up, 1.0 V Version, V_{IN} = 2.0 V

TYPICAL CHARACTERISTICS

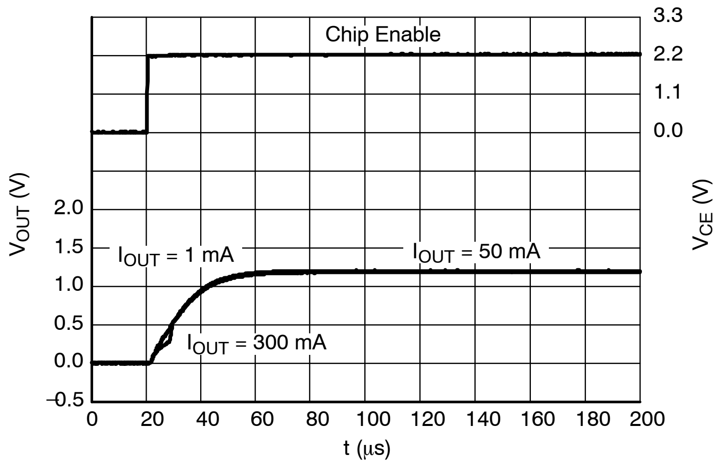


Figure 80. Start−up, 1.2 V Version, V_{IN} = 2.2 V

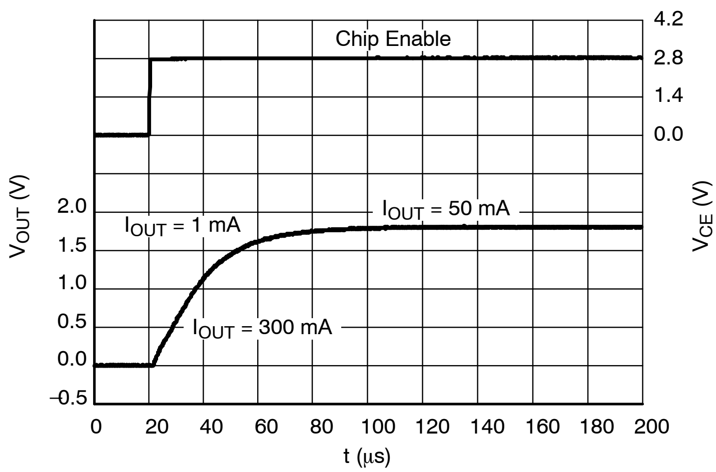


Figure 81. Start−up, 1.8 V Version, V_{IN} = 2.8 V

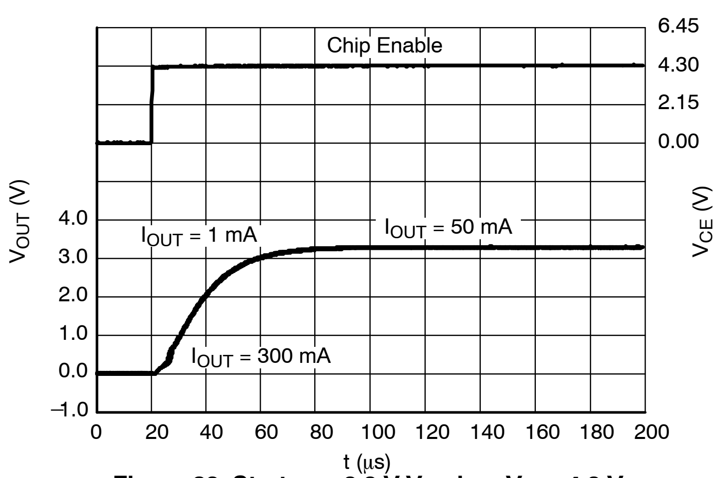


Figure 82. Start−up, 3.3 V Version, V_{IN} = 4.3 V

TYPICAL CHARACTERISTICS

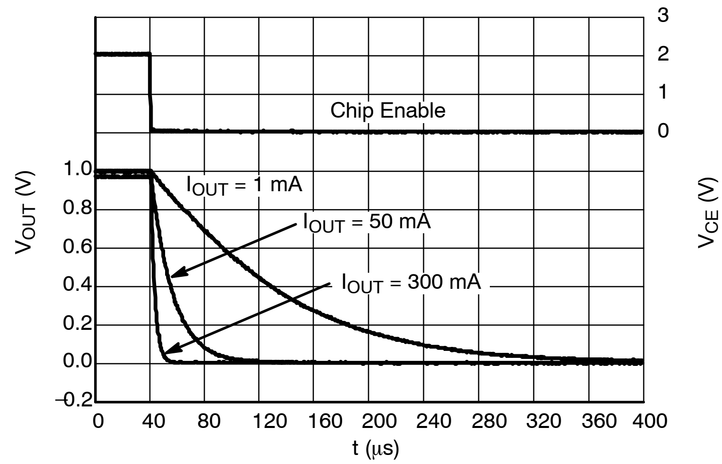


Figure 83. Shutdown, 1.0 V Version D, V_{IN} = 2.0 V

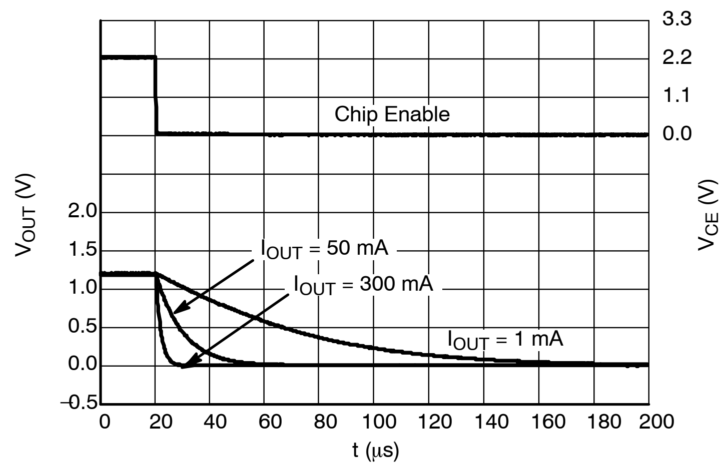


Figure 84. Shutdown, 1.2 V Version D, V_{IN} = 2.2 V

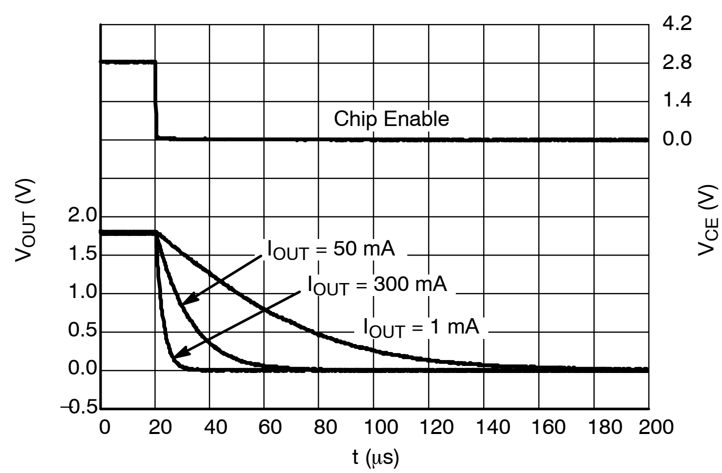


Figure 85. Shutdown, 1.8 V Version D, V_{IN} = 2.8 V

TYPICAL CHARACTERISTICS

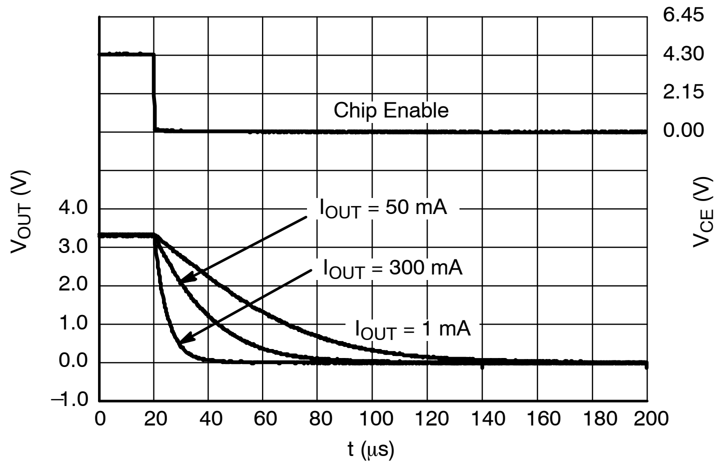


Figure 86. Shutdown, 3.3 V Version D, V_{IN} = 4.3 V

APPLICATION INFORMATION

A typical application circuit for NCP4589 series is shown in Figure 87.

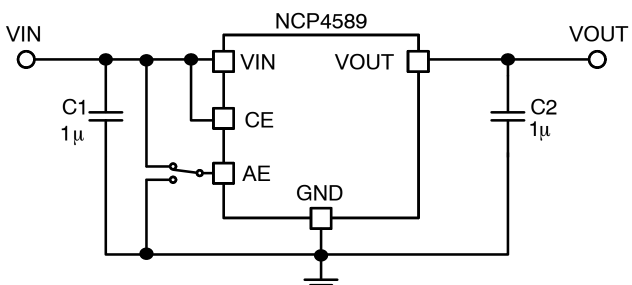


Figure 87. Typical Application Schematic

Input Decoupling Capacitor (C1)

A 1 μF ceramic input decoupling capacitor should be connected as close as possible to the input and ground pin of the NCP4589. Higher values and lower ESR improves line transient response.

Output Decoupling Capacitor (C2)

A 1 μF ceramic output decoupling capacitor is sufficient to achieve stable operation of the IC. If tantalum capacitor is used, and its ESR is high, the loop oscillation may result. If output capacitor is composed from few ceramic capacitors in parallel, the operation can be unstable. The capacitor should be connected as close as possible to the output and ground pin. Larger values and lower ESR improves dynamic parameters.

Enable Operation

The enable pin CE may be used for turning the regulator on and off. The regulator is switched on when CE pin voltage is above logic high level. The enable pin has internal pull down current source. If enable function is not needed connect CE pin to V_{IN}.

Current Limit

This regulator includes fold-back type current limit circuit. This type of protection doesn't limit current up to current capability in normal operation, but when over current occurs, the output voltage and current decrease until the over current condition ends. Typical characteristics of this protection type can be observed in the Output Voltage versus Output Current graphs shown in the typical characteristics chapter of this datasheet.

Output Discharger

The D version includes a transistor between V_{OUT} and GND that is used for faster discharging of the output capacitor. This function is activated when the IC goes into disable mode.

Auto ECO and Fast Mode

The NCP4589 has two operation modes that have impact on supply current and transient response at low output current. These two modes can be selected by AE pin. If AE pin is at low level Auto ECO mode is available. Please, see supply current vs. output current charts.

Thermal

As power across the IC increases, it might become necessary to provide some thermal relief. The maximum power dissipation supported by the device is dependent upon board design and layout. Mounting pad configuration on the PCB, the board material, and also the ambient temperature affect the rate of temperature rise for the part. That is to say, when the device has good thermal conductivity through the PCB, the junction temperature will be relatively low with high power dissipation applications.

PCB layout

Make V_{IN} and GND line sufficient. If their impedance is high, noise pickup or unstable operation may result. Connect capacitors C1 and C2 as close as possible to the IC, and make wiring as short as possible.

ORDERING INFORMATION

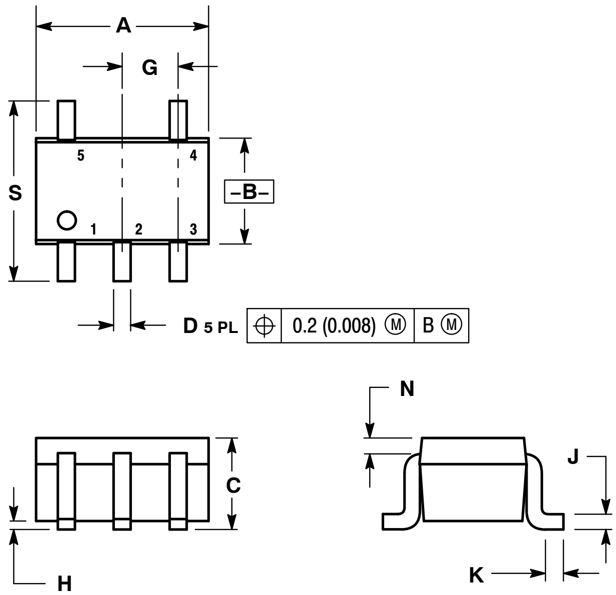
Device	Nominal Output Voltage	Description	Marking	Package	Shipping†
NCP4589DSQ12T1G	1.2 V	Auto discharge	D012	SC−70 (Pb−Free)	3000 / Tape & Reel
NCP4589DSQ18T1G	1.8 V	Auto discharge	D018	SC−70 (Pb−Free)	3000 / Tape & Reel
NCP4589DSQ25T1G	2.5 V	Auto discharge	D025	SC−70 (Pb−Free)	3000 / Tape & Reel
NCP4589DSQ30T1G	3.0 V	Auto discharge	D030	SC−70 (Pb−Free)	3000 / Tape & Reel
NCP4589DSQ33T1G	3.3 V	Auto discharge	D033	SC−70 (Pb−Free)	3000 / Tape & Reel
NCP4589DSN12T1G	1.2 V	Auto discharge	P1E	SOT−23−5 (Pb−Free)	3000 / Tape & Reel
NCP4589DSN18T1G	1.8 V	Auto discharge	P1L	SOT−23−5 (Pb−Free)	3000 / Tape & Reel
NCP4589DSN25T1G	2.5 V	Auto discharge	P1T	SOT−23−5 (Pb−Free)	3000 / Tape & Reel
NCP4589DSN30T1G	3.0 V	Auto discharge	P1Y	SOT−23−5 (Pb−Free)	3000 / Tape & Reel
NCP4589DSN33T1G	3.3 V	Auto discharge	Q1B	SOT−23−5 (Pb−Free)	3000 / Tape & Reel
NCP4589DMX12TCG	1.2 V	Auto discharge	7E	XDFN (Pb−Free)	5000 / Tape & Reel
NCP4589DMX18TCG	1.8 V	Auto discharge	7L	XDFN (Pb−Free)	5000 / Tape & Reel
NCP4589DMX28TCG	2.8 V	Auto discharge	7W	XDFN (Pb−Free)	5000 / Tape & Reel
NCP4589DMX30TCG	3.0 V	Auto discharge	7Y	XDFN (Pb−Free)	5000 / Tape & Reel
NCP4589DMX33TCG	3.3 V	Auto discharge	8B	XDFN (Pb−Free)	5000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

NOTE: To order other package and voltage variants, please contact your ON Semiconductor sales representative.

PACKAGE DIMENSIONS

SC−88A (SC−70−5/SOT−353)
CASE 419A−02
ISSUE K

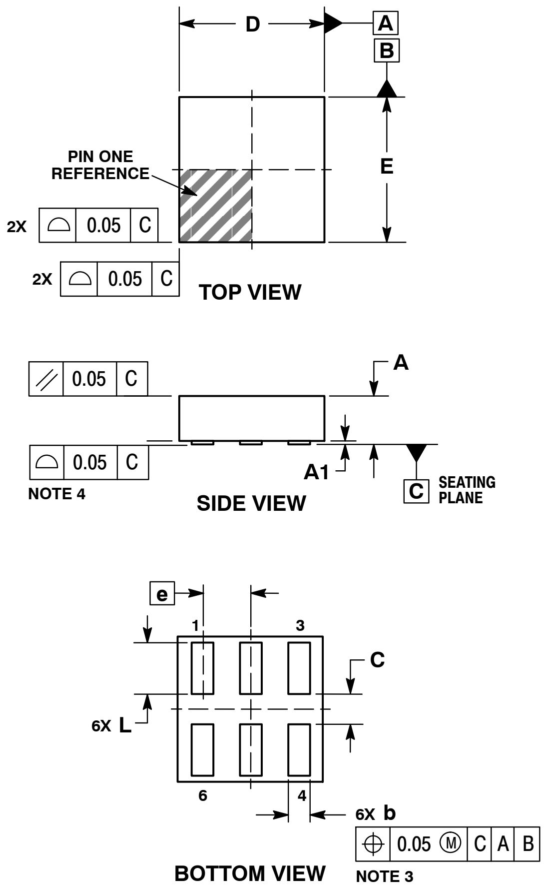


NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. 419A−01 OBSOLETE. NEW STANDARD 419A−02.
4. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.071	0.087	1.80	2.20
B	0.045	0.053	1.15	1.35
C	0.031	0.043	0.80	1.10
D	0.004	0.012	0.10	0.30
G	0.026 BSC		0.65 BSC	
H	---	0.004	---	0.10
J	0.004	0.010	0.10	0.25
K	0.004	0.012	0.10	0.30
N	0.008 REF		0.20 REF	
S	0.079	0.087	2.00	2.20

PACKAGE DIMENSIONS

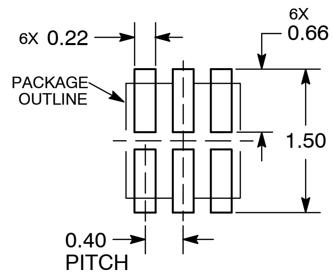
XDFN6 1.2x1.2, 0.4P
CASE 711AA−01
ISSUE O



NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.25mm FROM TERMINAL TIPS.
4. COPLANARITY APPLIES TO ALL OF THE TERMINALS.

	MILLIMETERS	
DIM	MIN	MAX
A	---	0.40
A1	0.00	0.05
b	0.13	0.23
C	0.20	0.30
D	1.20 BSC	
E	1.20 BSC	
e	0.40 BSC	
L	0.37	0.48

RECOMMENDED MOUNTING FOOTPRINT*

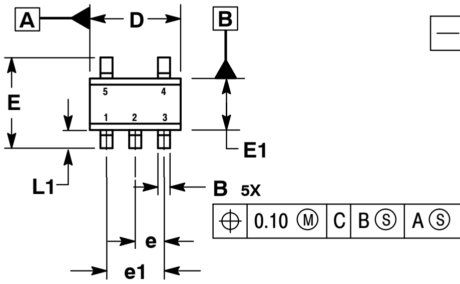


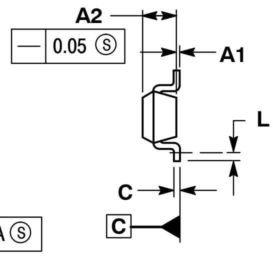
DIMENSIONS: MILLIMETERS

*For additional information on our Pb−Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

PACKAGE DIMENSIONS

SOT−23−5
CASE 1212−01
ISSUE O





NOTES:
1. DIMENSIONS ARE IN MILLIMETERS.
2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.
3. DATUM C IS A SEATING PLANE.

	MILLIMETERS	
DIM	MIN	MAX
A1	0.00	0.10
A2	1.00	1.30
B	0.30	0.50
C	0.10	0.25
D	2.80	3.00
E	2.50	3.10
E1	1.50	1.80
e	0.95 BSC	
e1	1.90 BSC	
L	0.20	---
L1	0.45	0.75

PUBLICATION ORDERING INFORMATION

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